

# PCUL11 Series Hardware Design

**LPWA Series** 

Version: 1.0.0

Date: 2024-04-23

Status: Preliminary



Our aim is to provide timely and comprehensive services to our customers. If you require any assistance, please contact our headquarters:

#### **NETPRISMA INC.**

1301 6TH AVE, SEATTLE, WA, 98101-2304, UNITED STATES Tel: +1 347 491 2229

Tel: +1 347 491 2229 Email: Info@netprisma.us

Or our local offices. For more information, please visit:

https://www.netprisma.us/sales-support/.

For technical support, or to report documentation errors, please visit:

https://www.netprisma.us/tech-support/ Or email us at: support@netprisma.us.

**Legal Notices** 

We offer information as a service to you. The provided information is based on your requirements and we make every effort to ensure its quality. You agree that you are responsible for using independent analysis and evaluation in designing intended products, and we provide reference designs for illustrative purposes only. Before using any hardware, software or service guided by this document, please read this notice carefully. Even though we employ commercially reasonable efforts to provide the best possible experience, you hereby acknowledge and agree that this document and related services hereunder are provided to you on an "as available" basis. We may revise or restate this document from time to time at our sole discretion without any prior notice to you.

# **Use and Disclosure Restrictions**

**License Agreements** 

Documents and information provided by us shall be kept confidential, unless specific permission is granted. They shall not be accessed or used for any purpose except as expressly provided herein.

Copyright

Our and third-party products hereunder may contain copyrighted material. Such copyrighted material shall not be copied, reproduced, distributed, merged, published, translated, or modified without prior written consent. We and the third party have exclusive rights over copyrighted material. No license shall be granted or conveyed under any patents, copyrights, trademarks, or service mark rights. To avoid ambiguities, purchasing in any form cannot be deemed as granting a license other than the normal non-exclusive, royalty-free license to use the material. We reserve the right to take legal action for noncompliance with abovementioned requirements, unauthorized use, or other illegal or malicious use of the material.

#### **Trademarks**

Except as otherwise set forth herein, nothing in this document shall be construed as conferring any rights to use any trademark, trade name or name, abbreviation, or counterfeit product thereof owned by NetPrisma or any third party in advertising, publicity, or other aspects.

**Third-Party Rights** 

This document may refer to hardware, software and/or documentation owned by one or more third parties ("third-party materials"). Use of such third-party materials shall be governed by all restrictions and obligations applicable thereto.

We make no warranty or representation, either express or implied, regarding the third-party materials, including but not limited to any implied or statutory, warranties of merchantability or fitness for a particular purpose, quiet enjoyment, system integration, information accuracy, and non-infringement of any third-party intellectual property rights with regard to the licensed technology or use thereof. Nothing herein constitutes a representation or warranty by us to either develop, enhance, modify, distribute, market, sell, offer for sale, or otherwise maintain production of any our products or any other hardware, software, device, tool, information, or product. We moreover disclaim any and all warranties arising from the course of dealing or usage of trade.

**Privacy Policy** 

To implement module functionality, certain device data are uploaded to NetPrisma's or third-party's servers, including carriers, chipset suppliers or customer-designated servers. NetPrisma, strictly abiding by the relevant laws and regulations, shall retain, use, disclose or otherwise process relevant data for the



purpose of performing the service only or as permitted by applicable laws. Before data interaction with third parties, please be informed of their privacy and data security policy.

# **Disclaimer**

- a) We acknowledge no liability for any injury or damage arising from the reliance upon the information.
- b) We shall bear no liability resulting from any inaccuracies or omissions, or from the use of the information contained herein.
- c) While we have made every effort to ensure that the functions and features under development are free from errors, it is possible that they could contain errors, inaccuracies, and omissions. Unless otherwise provided by valid agreement, we make no warranties of any kind, either implied or express, and exclude all liability for any loss or damage suffered in connection with the use of features and functions under development, to the maximum extent permitted by law, regardless of whether such loss or damage may have been foreseeable.
- d) We are not responsible for the accessibility, safety, accuracy, availability, legality, or completeness of information, advertising, commercial offers, products, services, and materials on third-party websites and third-party resources.

Copyright © NETPRISMA INC. 2024. All rights reserved.



# **Revision History**

Version	Date	Description
-	2024-04-23	Creation of the document
1.0.0	2024-04-23	Preliminary



# **Contents**

<b>Tabl</b>	itentsle Indexure Index	6
	Introduction	<b>8</b>
	Product Overview	13 14 16 18
	2.6. EVB Kit  Operating Characteristics	24 <b>25</b>
	3.1. Operating Modes. 3.2. Power Saving	25 25 26 27 27 27 27 27 29 29 31 32
	3.4.2.2. Turn Off with AT Command 3.4.3. Fast Shutdown 3.5. RESET_N	32
	Application Interfaces  4.1 PON_TRIG Interface.  4.2 (U)SIM Interface.  4.3 USB Interface.  4.4 UART Interfaces.  4.5 PCM and I2C Interfaces.  4.6 Network Status Indication  4.7 STATUS  4.8 MAIN_RI.  4.9 USB_BOOT.  4.10 ADC Interfaces.  4.11 GPIO Interfaces.  4.12 GRFC Interfaces.	35 37 39 42 43 44 44 46 47 47
	GNSS	49 49 50
	Antenna Interfaces  6.1. Main Antenna Interface  6.1.1. Pin Definition  6.1.2. Operating Frequency  6.1.3. Reference Design  6.2. GNSS Antenna Interface  6.2.1. Pin Definition  6.2.2. GNSS Operating Frequency  6.2.3. Reference Design  6.3. RF Routing Guidelines	51 51 52 53 53 53



	6.4. Antenna Installation	. 56
	6.4.1. Requirements for Antenna Design	. 56
	6.4.2. RF Connector Recommendation	. 57
7	Electrical Characteristics and Reliability	. 59
	7.1. Absolute Maximum Ratings	. 59
	7.2. Power Supply Ratings	. 59
	7.3. Operating and Storage Temperatures	. 60
	7.4. Power Consumption	. 60
	7.4.1. PCUL11-LD1 Power Consumption	. 60
	7.4.2. PCUL11-LD Power Consumption	. 61
	7.4.3. PCUL11 Series GNSS Power Consumption	. 64
	7.5. Tx Power	
	7.6. Rx Sensitivity	. 65
	7.7. ESD Protection	. 67
8	Mechanical Information	. 68
	8.1. Mechanical Dimensions	
	8.2. Recommended Footprint	
	8.3. Top and Bottom Views	. 70
9	Storage, Manufacturing and Packaging	. 72
	9.1. Storage Conditions	. 72
	9.2. Manufacturing and Soldering	. 73
	9.3. Packaging Specifications	
	9.3.1. Carrier Tape	. 74
	9.3.2. Plastic Reel	
	9.3.3. Mounting Direction	
	9.3.4. Packaging Process	
10	Appendix A References	. 78



# **Table Index**

Table 1: Special Mark	12
Table 1: Special Mark Table 2: Different Selections of PCUL11 Series Module	13
Table 3: Frequency Bands of PCUL11 Series Module	13
Table 4: Key Features of PCUL11 Series Module	14
Table 5: Definition of I/O Parameters	19
Table 6: Pin Description	19
Table 6: Pin DescriptionTable 7: Operating Modes of PCUL11 Series Module	25
Table 8: VBAT and GND Pins	27
Table 9: Pin Definition of PWRKEY	20
Table 10: Pin Definition of Fast Shutdown Interface	23
Table 11: Pin Definition of RESET_N	∆∠
Table 11. Pin Definition of RESET_N	33 25
Table 12. Pin Definition of PON_TRIG Interface	33
Table 13: Pin Definition of (U)SIM Interface	პე
Table 14: Pin Definition of USB Interface	38
Table 15: Pin Definition of Main UART Interface	39
Table 16: Pin Definition of Debug UART Interface	40
Table 17: Pin Definition of GNSS UART Interface	40
Table 18: Pin Definition of PCM and I2C Interfaces	42
Table 19: Pin Definition of NET_STATUS	43
Table 19: Pin Definition of NET_STATUS Table 20: Operating State of NET_STATUS	43
Table 21: Pin Definition of STATUS	43
Table 22: Default Behaviours of MAIN_RI	44
Table 23: Pin Definition of USB BOOT Interface	44
Table 24: Pin Definition of ADC Interfaces	46
Table 25: Characteristics of ADC Interfaces	46
Table 26: Pin Definition of GPIO Interfaces	47
Table 27: Pin Definition of GRFC Interfaces	47
Table 28: Truth Table of GRFC Interfaces	47
Table 29: GNSS Performance	
Table 30: Pin Definition of Main Antenna Interface	51
Table 31: Operating Frequency of PCUL11 Series Module	51
Table 32: Pin Definition of GNSS Antenna Interface	51 53
Table 32: Fit Definition of Onos Africana internace	53
Table 33: GNSS Operating Frequency Table 34: Requirements for Antenna Design	55 56
Table 34. Requirements for America Design	50
Table 35: Absolute Maximum Ratings	
Table 36: Power Supply Ratings	59
Table 37: Operating and Storage Temperatures	60
Table 38: PCUL11-LD1 Power Consumption (3.3 V Power Supply, Room Temperature)	60
Table 39: PCULTI-LD Power Consumption (3.8 v Power Supply, Room Temperature)	61
Table 40: GNSS Power Consumption of PCUL11-LD1 (3.3 V Power Supply, Room Temperature)	64
Table 40: GNSS Power Consumption of PCUL11-LD1 (3.3 V Power Supply, Room Temperature) Table 41: GNSS Power Consumption of PCUL11-LD (3.8 V Power Supply, Room Temperature)	64
Table 42: Conducted Tx Power of PCUL11 Series	64
Table 43: PCUL11-LD1 Conducted Rx Sensitivity	65
Table 44: PCUL11-LD Conducted Rx Sensitivity	66
Table 45: Electrostatic Discharge Characteristics (Temperature: 25–30 °C, Humidity: 40 ±5 %)	67
Table 46: Recommended Thermal Profile Parameters	73
Table 47: Carrier Tane Dimension Table (Unit: mm)	75
Table 48: Plastic Reel Dimension Table (Unit: mm)  Table 49: Packaging Specifications of PCUL11 Series Module	75
Table 49: Packaging Specifications of PCUL11 Series Module	77
Table 50: Related Documents	78
Table 51: Terms and Abbreviations	78



# **Figure Index**

Figure 1: Functional Diagram of PCUL11-LD1	.16
Figure 2: Functional Diagram of PCUL11-LD	. 17
Figure 3: Pin Assignment	18
Figure 4: Sleep Mode Application via UART Interface	27
Figure 5: Power Supply Limits During Burst Transmission (PCUL11-LD)	28
Figure 6: Star Structure of the Power Supply	29
Figure 6: Star Structuré of the Power Supply	30
Figure 8: Turn On the Module with a Push Button	.30
Figure 9: Turn-on Timing	
Figure 10: Turn-off Timing	32
Figure 11: Fast Shutdown TimingFigure 12: Reference Design of RESET_N with a Driver Circuit	33
Figure 12: Reference Design of RESET_N with a Driver Circuit	33
Figure 13: Reference Design of RESEL N with a Push Button	34
Figure 14: Reset Timing  Figure 15: Reference Design of PON_TRIG  Figure 17: Reference Design of (U)SIM Interface with a 8-Pin (U)SIM Card Connector  Figure 17: Reference Design of (U)SIM Interface with a 6-Pin (U)SIM Card Connector	34
Figure 15: Reference Design of PON_TRIG	35
Figure 17: Reference Design of (U)SIM Interface with a 8-Pin (U)SIM Card Connector	36
Figure 17: Reference Design of (U)SIM Interface with a 6-Pin (U)SIM Card Connector	37
Figure 17: Reference Design of USB Interface	38
Figure 19: Main UART Interface Reference Design (IC Solution)	40
Figure 20: Main UART Interface Reference Design (Transistor Solution)	41
Figure 21: GNSS UART Interface Reference Design (IC Solution Without Internal Pull-up)	41
Figure 22: Reference Design of PCM and I2C Application with Audio Codec	42
Figure 23: Reference Design of the Network Status Indicator	43
Figure 24: Reference Design of STATUS	44
Figure 25: Reference Design of USB_BOOT Interface	45
Figure 26: Timing for Turning on the Module with USB_BOOT	45
Figure 27: Reference Design of Main Antenna Interface	52
Figure 28: Reference Design of GNSS Antenna Interface	53
Figure 29: Microstrip Design on a 2-layer PCB	54
Figure 30: Coplanar Waveguide Design on a 2-layer PCB	54
Figure 31: Coplanar Waveguide Design on a 4-layer PCB (Layer 3 as Reference Ground)	55
Figure 32: Coplanar Waveguide Design on a 4-layer PCB (Layer 4 as Reference Ground)	55
Figure 33: Dimensions of the Receptacle (Unit: mm)	5/
Figure 34: Specifications of Mated Plugs	5/
Figure 35: Space Factor of Mated Connectors (Unit: mm)	58
Figure 36: Module Top and Side Dimensions (Unit: mm)	68
Figure 37: Module Bottom Dimensions	
Figure 38: Recommended Footprint	70
Figure 39: Top and Bottom Views of the Module	71
Figure 40: Recommended Reflow Soldering Thermal Profile	13
Figure 41: Carrier Tape Dimension Drawing (Unit: mm)  Figure 42: Plastic Reel Dimension Drawing	75
Figure 42: Plastic Keel Dimension Drawing	75
Figure 43: Mounting Direction	76
Figure 44: Packaging Process	11



# 1 Introduction

This document defines PCUL11 series module and describes its air and hardware interfaces which connect to your applications.

This document helps you quickly understand the interface specifications, electrical and mechanical details, as well as other related information of PCUL11 series. To facilitate application designs, it also includes some reference designs. The document, coupled with application notes and user guides, makes it easy to design and set up mobile applications with the module.

#### FCC Certification Requirements.

According to the definition of mobile and fixed device is described in Part 2.1091(b), this device is a mobile device.

And the following conditions must be met:

- This Modular Approval is limited to OEM installation for mobile and fixed applications only. The
  antenna installation and operating configurations of this transmitter, including any applicable
  source-based timeaveraging duty factor, antenna gain and cable loss must satisfy MPE categorical
  Exclusion Requirements of 2.1091.
- 2. The EUT is a mobile device; maintain at least a 20 cm separation between the EUT and the user's body and must not transmit simultaneously with any other antenna or transmitter.
- 3. A label with the following statements must be attached to the host end product: This device contains FCC ID: 2BEY3PCUL11LD1A
- 4. To comply with FCC regulations limiting both maximum RF output power and human exposure to RF radiation, maximum antenna gain (including cable loss) must not exceed:

Operating Band	Peak gain	Manufacturer	Impedance	Antenna type
WCDMA Band II	1.59 dBi			
WCDMA Band IV	2.00 dBi			
WCDMA Band V	2.53 dBi			
LTE Band 2	1.59 dBi	Changhai Caintanna		
LTE Band 4	2.00 dBi	Shanghai Saintenna Electronic Technology		
LTE Band 5	2.53 dBi	Co., Ltd.	50Ω	External Antenna
LTE Band 12	3.95 dBi	O., Liu.		LAGINAI AIREIIIA
LTE Band 13	4.45 dBi			
LTE Band 25	1.59 dBi			
LTE Band 26(814-824)	3.19 dBi			
LTE Band 26(824-849)	2.53 dBi			

- 5. This module must not transmit simultaneously with any other antenna or transmitter
- 6. The host end product must include a user manual that clearly defines operating requirements and conditions that must be observed to ensure compliance with current FCC RF exposure guidelines. For portable devices, in addition to the conditions 3 through 6 described above, a separate approval is required to satisfy the SAR requirements of FCC Part 2.1093

If the device is used for other equipment that separate approval is required for all other operating configurations, including portable configurations with respect to 2.1093 and different antenna configurations.

For this device, OEM integrators must be provided with labeling instructions of finished products. Please refer to KDB784748 D01 v07, section 8. Page 6/7 last two paragraphs:

A certified modular has the option to use a permanently affixed label, or an electronic label. For a permanently affixed label, the module must be labeled with an FCC ID - Section 2.926 (see 2.2



Certification (labeling requirements) above). The OEM manual must provide clear instructions explaining to the OEM the labeling requirements, options and OEM user manual instructions that are required (see next paragraph).

For a host using a certified modular with a standard fixed label, if (1) the module's FCC ID is not visible when installed in the host, or (2) if the host is marketed so that end users do not have straightforward commonly used methods for access to remove the module so that the FCC ID of the module is visible; then an additional permanent label referring to the enclosed module: "Contains Transmitter Module FCC ID: 2BEY3PCUL11LD1A" or "Contains FCC ID: 2BEY3PCUL11LD1A" must be used. The host OEM user manual must also contain clear instructions on how end users can find and/or access the module and the FCC ID.

The final host / module combination may also need to be evaluated against the FCC Part 15B criteria for unintentional radiators in order to be properly authorized for operation as a Part 15 digital device.

The user's manual or instruction manual for an intentional or unintentional radiator shall caution the user that changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment. In cases where the manual is provided only in a form other than paper, such as on a computer disk or over the Internet, the information required by this section may be included in the manual in that alternative form, provided the user can reasonably be expected to have the capability to access information in that form.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the manufacturer could void the user's authority to operate the equipment.

To ensure compliance with all non-transmitter functions the host manufacturer is responsible for ensuring compliance with the module(s) installed and fully operational. For example, if a host was previously authorized as an unintentional radiator under the Supplier's Declaration of Conformity procedure without a transmitter certified module and a module is added, the host manufacturer is responsible for ensuring that the after the module is installed and operational the host continues to be compliant with the Part 15B unintentional radiator requirements.

#### **Manual Information To the End User**

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

#### **IC Statement**

#### **IRSS-GEN**

"This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions: (1) This device may not cause interference; and (2) This device must accept any interference, including interference that may cause undesired operation of the device." or "Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

1) l'appareil ne doit pas produire de brouillage; 2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement." Déclaration sur l'exposition aux rayonnements RF

L'autre utilisé pour l'émetteur doit être installé pour fournir une distance de séparation d'au moins 20 cm

number".



de toutes les personnes et ne doit pas être colocalisé ou fonctionner conjointement avec une autre antenne ou un autre émetteur.

The host product shall be properly labeled to identify the modules within the host product.

The Innovation, Science and Economic Development Canada certification label of a module shall be clearly visible at all times when installed in the host product; otherwise, the host product must be labeled to display the Innovation, Science and Economic Development Canada certification number for the module, preceded by the word "Contains" or similar wording expressing the same meaning, as follows: "Contains IC: 32052-PCUL11LD1A" or "where: 32052-PCUL11LD1A is the module's certification

Le produit hôte doit être correctement étiqueté pour identifier les modules dans le produit hôte. L'étiquette de certification d'Innovation, Sciences et Développement économique Canada d'un module doit être clairement visible en tout temps lorsqu'il est installédans le produit hôte; sinon, le produit hôte doit porter une étiquette indiquant le numéro de certification d'Innovation, Sciences et Développement économique Canada pour le module, précédé du mot «Contient» ou d'un libellé semblable exprimant la même signification, comme suit:

"Contient IC: 32052-PCUL11LD1A" ou "où: 32052-PCUL11LD1A est le numéro de certification du module".



### KDB 996369 D03 OEM Manual rule sections:

**2.2 List of applicable FCC rules**This module has been tested for compliance to FCC Part 15.247

<u>2.3 Summarize the specific operational use conditions</u>
The module is tested for standalone mobile RF exposure use condition. Any other usage conditions such as co-location with other transmitter(s) or being used in a portable condition will need a separate reassessment through a class 2 permissive change application or new certification.

# **2.4 Limited module procedures** Not applicable.

#### 2.5 Trace antenna designs

Not applicable.

2.6 RF exposure considerations
This equipment complies with FCC mobile radiation exposure limits set forth for an controlled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator & your body. If the module is installed in a portable host, a separate SAR evaluation is required to confirm compliance with relevant FCC portable RF exposure rules.

#### 2.7 Antennas

Please refer to page 8 of the manual

<u>2.8 Label and compliance information</u>
The host system using this module, should have label in a visible area indicated the following texts: "Contains FCC ID: 2BEY3LCUH22LDA, Contains IC: 32052-LCUH22LDA"

**2.9 Information on test modes and additional testing requirements5**Top band can increase the utility of our modular transmitters by providing instructions that simulates or characterizes a connection by enabling a transmitter.

2.10 Additional testing, Part 15 Subpart B disclaimer
The module without unintentional-radiator digital circuity, so the module does not require an evaluation by FCC Part 15 Subpart B. The host should be evaluated by the FCC Subpart B.

<u>2.11 Note EMI Considerations</u>
Please follow the guidance provided for host manufacturers in KDB publications 996369 D02 and D04.

#### 2.12 How to make changes

Only Grantees are permitted to make permissive changes.

**IMPORTANT NOTE:** In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization



# 1.1. Special Mark

# Table 1: Special Mark

Mark	Definition
*	Unless otherwise specified, an asterisk (*) after a function, feature, interface, pin name, command, argument, and so on indicates that it is under development and currently not supported; and the asterisk (*) after a model indicates that the model sample is currently unavailable.



# **2** Product Overview

PCUL11 is a series of embedded IoT (LTE Cat M1, LTE Cat NB2, EGPRS) wireless communication modules. It provides data connectivity on LTE HD-FDD, GPRS/EGPRS networks. It also provides GNSS functions to meet your specific application demands.

# 2.1. General Description

The module is based on an architecture in which WWAN and GNSS Rx chains share certain hardware blocks. However, the module does not support concurrent operation of WWAN and GNSS. The solution adopted in the module is a form of coarse time-division multiplexing (TDM) between WWAN and GNSS Rx chains. Given the relaxed latency requirements of most LPWA applications, time-division sharing of resources can be made largely transparent to applications. For more details, see *document* [1].

PCUL11 series is an industrial-grade module for industrial and commercial applications only.

Table 2: Different Selections of PCUL11 Series Module

Model	Cat M1	Cat NB2 1	GSM	GNSS
PCUL11-LD1	$\sqrt{}$	-	-	$\sqrt{}$
PCUL11-LD	$\sqrt{}$	$\sqrt{}$	$\sqrt{}$	$\checkmark$

#### **NOTE**

- 1. √: Supported.
- 2. -: Not supported.

Table 3: Frequency Bands of PCUL11 Series Module

Model	Supported Bands	LTE Bands Power Class	GNSS
PCUL11-LD1	Cat M1 Only: LTE HD-FDD: B1/B2/B3/B4/B5/B8/B12/B13/B18/ B19/B20/B25/B26/B27/B28/B66/B85	Power Class 5 (21 dBm)	GPS, GLONASS, BDS, Galileo, QZSS
PCUL11-LD	Cat M1: LTE HD-FDD: B1/B2/B3/B4/B5/B8/B12/B13/B18/ B19/B20/B25/B26/B27/B28/B66/B85 Cat NB2: LTE HD-FDD: B1/B2/B3/B4/B5/B8/B12/B13/B18/ B19/B20/B25/B28/B66/B71/B85 EGPRS:	Power Class 5 (21 dBm)	GPS, GLONASS, BDS, Galileo, QZSS

<sup>&</sup>lt;sup>1</sup> LTE Cat NB2 is backward compatible with LTE Cat NB1.



#### GSM850/EGSM900/DCS1800/PCS1900

With such a compact size as 23.6 mm × 19.9 mm × 2.2 mm, the module can meet different requirements for M2M applications such as smart metering, tracking system, security and wireless POS.

PCUL11 is a series of SMD type module that can be embedded into applications through the 102 LGA pins. It supports internet service protocols like TCP, UDP and PPP. Based on extended AT commands developed by NetPrisma, you can use these internet service protocols easily.

## 2.2. Key Features

Table 4: Key Features of PCUL11 Series Module

Features	Details			
Power Supply	PCUL11-LD1:  ■ Supply voltage <sup>2</sup> : 2.6–4.8 V  ■ Typical supply voltage: 3.3 V  PCUL11-LD:  ■ Supply voltage: 3.3–4.3 V  ■ Typical supply voltage: 3.8 V			
Transmitting Power <sup>3</sup>	LTE HD-FDD bands:			
LTE Features <sup>4</sup>	<ul> <li>Supports 3GPP Rel-14</li> <li>Supports LTE Cat M1 and LTE Cat NB2</li> <li>Supports 1.4 MHz RF bandwidth for LTE Cat M1</li> <li>Supports 200 kHz RF bandwidth for LTE Cat NB2</li> <li>Max. transmission data rates: Cat M1: 588 kbps (DL)/1119 kbps (UL) Cat NB2: 127 kbps (DL)/158.5 kbps (UL)</li> </ul>			
GSM Features <sup>4</sup>	<ul> <li>GPRS:</li> <li>Supports GPRS multi-slot class 33 (33 by default)</li> <li>Coding scheme: CS 1–4</li> <li>Max. 107 kbps (DL)/ Max. 85.6 kbps (UL)</li> <li>EDGE:</li> </ul>			

<sup>&</sup>lt;sup>2</sup> For every VBAT transition/re-insertion from 0 V, the minimum power supply voltage should be higher than 2.7 V. After the module starts up normally, the minimum safety voltage is 2.6 V. To ensure full functionality mode, the minimum power supply voltage should be higher than 2.8 V.

<sup>3</sup> See *Table 3* or *Chapter 7.5* for the LTE bands power class level of each model.

<sup>4</sup> See *Table 3* or *Chapter 7.5* for the LTE and GSM features of each model.



Internet Protocol Features	<ul> <li>Supports EDGE multi-slot class 33 (33 by default)</li> <li>Supports GMSK and 8-PSK for different MCS (Modulation and Coding Scheme)</li> <li>Downlink coding schemes: MCS 1–9</li> <li>Uplink coding schemes: MCS 1–9</li> <li>Max. 296 kbps (DL)/ Max. 236.8 kbps (UL)</li> <li>Supports PPP/TCP/UDP/SSL/TLS/FTP(S)/HTTP(S)/NITZ/PING/MQTT/LwM2M/CoAP/IPv6 protocols</li> <li>Supports PAP and CHAP for PPP connections</li> </ul>
SMS	<ul> <li>Text and PDU mode</li> <li>Point-to-point MO and MT</li> <li>SMS cell broadcast</li> <li>SMS storage: ME by default</li> </ul>
(U)SIM Interface	Supports 1.8 V USIM/SIM card only
PCM Interface	Supports one digital audio interface: PCM interface
USB Interface	<ul> <li>Compliant with USB 2.0 specification (slave only)</li> <li>Supports operations at high-speed, full-speed and low-speed modes</li> <li>Used for AT command communication, data transmission, GNSS NMEA sentences output, software debugging and firmware upgrade</li> <li>Supports USB serial drivers for Windows 8/8.1/10/11, Linux 2.6–6.7, Android 4.x–13.x</li> </ul>
UART Interfaces	<ul> <li>Main UART Interface:</li> <li>Used for data transmission and AT command communication</li> <li>115200 bps by default</li> <li>The default frame format is 8N1 (8 data bits, no parity, 1 stop bit)</li> <li>Supports RTS and CTS hardware flow control</li> <li>Debug UART Interface:</li> <li>Used for software debugging and log output</li> <li>Supports 115200 bps</li> <li>GNSS UART Interface:</li> <li>Used for GNSS data and NMEA sentences output</li> <li>115200 bps baud rate by default</li> </ul>
GNSS Features	<ul><li>GPS, GLONASS, BDS, Galileo and QZSS</li><li>1 Hz data update rate by default</li></ul>
AT Commands	<ul> <li>3GPP TS 27.007 and 3GPP TS 27.005 AT commands</li> <li>Enhanced AT commands</li> </ul>
Network Indication	One NET_STATUS pin for network activity status indication
Antenna Interfaces	<ul><li>Main antenna interface (ANT_MAIN)</li><li>GNSS antenna interface (ANT_GNSS)</li></ul>
Physical Characteristics	<ul> <li>Dimensions: (23.6 ±0.2) mm × (19.9 ±0.2) mm × (2.2 ±0.2) mm</li> <li>Weight: approx. 2.15 g</li> </ul>



Temperature Range	<ul> <li>Operating temperature range: -35 to +75 °C <sup>5</sup></li> <li>Extended temperature range: -40 to +85 °C <sup>6</sup></li> <li>Storage temperature range: -40 to +90 °C</li> </ul>	
Firmware Upgrade	USB interface, DFOTA	
RoHS	All hardware components are fully compliant with EU RoHS directive	

# 2.3. Functional Diagram

The following figures show the block diagram of PCUL11 series and the major functional parts.

- Power management
- Baseband
- Radio frequency
- Peripheral interfaces

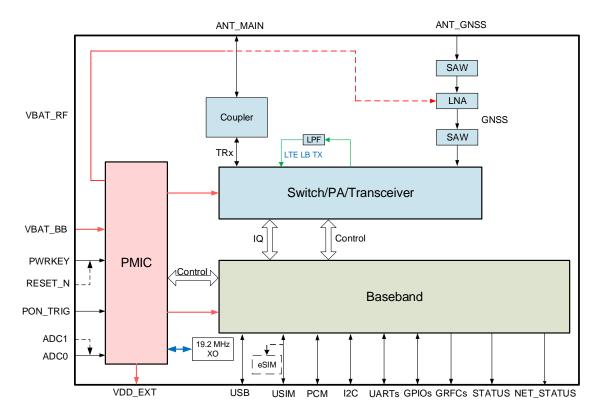


Figure 1: Functional Diagram of PCUL11-LD1

<sup>&</sup>lt;sup>5</sup> Within the operating temperature range, the module meets 3GPP specifications.
<sup>6</sup> Within the extended temperature range, the module remains the ability to establish and maintain functions such as SMS and data transmission, without any unrecoverable malfunction. Radio spectrum and radio network are not influenced, while one or more specifications, such as Pout, may exceed the specified tolerances of 3GPP. When the temperature returns to the operating temperature range, the module meets 3GPP specifications again.

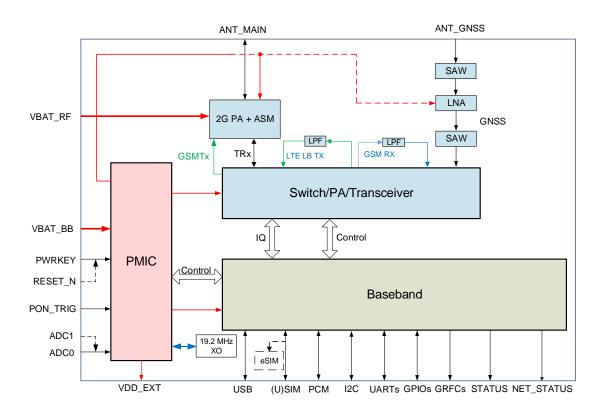


Figure 2: Functional Diagram of PCUL11-LD

#### **NOTE**

- 1. eSIM\* function is optional. If eSIM is selected, then any external (U)SIM card cannot be used simultaneously.
- 2. The output voltage of PWRKEY is 1.5 V because of the voltage drop inside the chipset. Due to platform limitations, the chipset has integrated the reset function into PWRKEY. Therefore, never pull down PWRKEY to GND permanently.
- 3. RESET\_N connects directly to PWRKEY inside the module.
- Do not use ADC0 and ADC1 simultaneously, as ADC1 connects directly to ADC0 inside the module. PCUL11 series supports the use of only one ADC interface at a time: either ADC0 or ADC1.

# 2.4. Pin Assignment

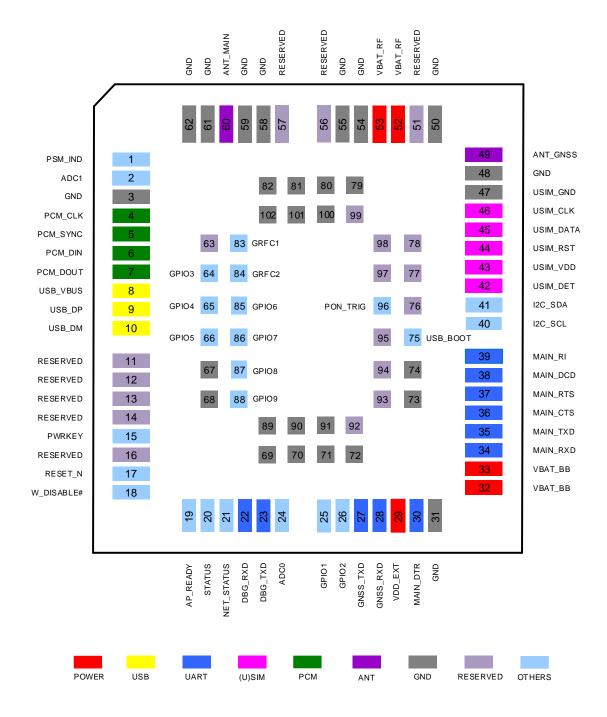


Figure 3: Pin Assignment

#### **NOTE**

1. Do not use ADC0 and ADC1 simultaneously, as ADC1 connects directly to ADC0 inside the



- module. PCUL11 series supports the use of only one ADC interface at a time: either ADC0 or ADC1.
- 2. The output voltage of PWRKEY is 1.5 V because of the voltage drop inside the chipset. Due to platform limitations, the chipset has integrated the reset function into PWRKEY. Therefore, never pull down PWRKEY to GND permanently.
- 3. RESET\_N connects directly to PWRKEY inside the module.
- 4. GNSS\_TXD (pin 27) and GRFC2 (pin 84) are BOOT\_CONFIG pins. Never pull them up before startup, otherwise the module cannot power on normally.
- 5. GPIO1 (pin 25) supports fast shutdown function. This function is disabled by default. See *Chapter* 3.4.3 for more details.
- 6. Keep all RESERVED and unused pins unconnected.
- 7. Connect GND pins to the ground in the design.

# 2.5. Pin Description

Table 5: Definition of I/O Parameters

Parameter	Description
Al	Analog Input
AO	Analog Output
AIO	Analog Input/Output
DI	Digital Input
DIO	Digital Input/Output
DO	Digital Output
OD	Open Drain
PI	Power Input
РО	Power Output

DC characteristics include power domain and rated current.

Table 6: Pin Description

Power Supply						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
VBAT_BB	32, 33	PI	Power supply for the module's baseband part	<b>PCUL11-LD1</b> 7: Vmax = 4.8 V Vmin = 2.6 V		



VBAT_RF	52, 53	ΡI	Power supply for the module's RF part	Vnom = 3.3 V PCUL11-LD: Vmax = 4.3 V Vmin = 3.3 V Vnom = 3.8 V			
VDD_EXT	29	РО	Provides 1.8 V for external circuits	Vnom = 1.8 V I <sub>O</sub> max = 50 mA	Test point is recommended to be reserved. If unused, keep this pin open.		
GND 3, 31, 48, 50, 54, 55, 58, 59, 61, 62, 67–74, 79–82, 89–91, 100–102							
Turn-on/Turn-o	ff the Mod	lule					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment		
PWRKEY	15	DI	Turn on/off the module	Vnom = 1.5 V V <sub>IL</sub> max = 0.45 V	Never pull down PWRKEY to GND permanently. The output voltage is 1.5 V because of the voltage drop inside the chipset.		
Reset the Module							
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment		
RESET_N	17	DI	Reset the module	Vnom = 1.5 V V <sub>IL</sub> max = 0.45 V	Multiplexed from PWRKEY (connects directly to PWRKEY inside the module). If unused, keep it open. A test point is recommended to be reserved if unused.		
Status Indication	on Interfac	es					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment		
PSM_IND <sup>8</sup>	1	DO	Indicate the module's power saving mode				
STATUS	20	DO	Indicate the module's operation status	$V_{OH}$ min = 1.35 V $V_{OL}$ max = 0.45 V	1.8 V power domain. If unused, keep these pins open.		
NET_STATUS	21	DO	Indicate the module's network activity status		pine opein		
PON_TRIG Inte	rface						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment		
PON_TRIG	96	DI	Wake up the module from PSM		1.8 V power domain. Rising-edge triggered. Pulled-down by default. If unused, keep this pin open.		
USB Interface							

<sup>&</sup>lt;sup>8</sup> When PSM is enabled, the function of PSM\_IND pin will be activated after the module is rebooted. When PSM\_IND is in high voltage level, the module is in full functionality mode. When it is in low voltage level, the module is in PSM.



Pin Name	Pin No.	I/O	Description	<b>DC Characteristics</b>	Comment
USB_VBUS	8	Al	USB connection detect	Vmax = 5.25 V Vmin = 4.0 V Vnom = 5.0 V	Typical 5.0 V. Test point must be reserved.
USB_DP	9	AIO	USB differential data (+)	-	Compliant with USB 2.0 standard specification. Require
USB_DM	10	AIO	USB differential data (-)		differential impedance of 90 $\Omega$ . Test points must be reserved.
(U)SIM Interfac	е				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
USIM_DET	42	DI	(U)SIM card hot-plug detect	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. If unused, keep this pin open.
USIM_VDD	43	РО	(U)SIM card power supply	Vmax = 1.9 V Vmin = 1.7 V	Only 1.8 V (U)SIM card is supported.
USIM_RST	44	DO	(U)SIM card reset	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	1.8 V power domain.
USIM_DATA	45	DIO	(U)SIM card data	$\begin{split} &V_{IL}\text{min} = -0.3 \text{ V} \\ &V_{IL}\text{max} = 0.6 \text{ V} \\ &V_{IH}\text{min} = 1.2 \text{ V} \\ &V_{IH}\text{max} = 2.0 \text{ V} \\ &V_{OL}\text{max} = 0.45 \text{ V} \\ &V_{OH}\text{min} = 1.35 \text{ V} \end{split}$	1.8 V power domain.
USIM_CLK	46	DO	(U)SIM card clock	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	1.8 V power domain.
USIM_GND	47	-	Specified ground for (U)SIM card		
Main UART					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
MAIN_DTR	30	DI	Main UART data terminal ready	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V	
MAIN_RXD	34	DI	Main UART receive	$V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. If unused, keep these pins open.
MAIN_TXD	35	DO	Main UART transmit		pino oponi
MAIN_CTS	36	DO	Clear to send signal from the module	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	Connect to the MCU's CTS.  1.8 V power domain. If unused, keep the pin open.
MAIN_RTS	37	DI	Request to send signal to the module	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	Connect to the MCU's RTS. 1.8 V power domain. If unused, keep the pin open.
MAIN_DCD	38	DO	Main UART data carrier detect	V <sub>OL</sub> max = 0.45 V	1.8 V power domain.
MAIN_RI	39	DO	Main UART ring indication	$V_{OH}$ min = 1.35 V	If unused, keep these pins open.
Debug UART					



Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
DBG_RXD	22	DI	Debug UART receive	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. If unused, keep these pins open.
DBG_TXD	23	DO	Debug UART transmit	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	Test points must be reserved.
GNSS UART					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
GNSS_TXD	27	DO	GNSS UART transmit	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	BOOT_CONFIG. Do not pull it up before startup. 1.8 V power domain. If unused, keep this pin open.
GNSS_RXD	28	DI	GNSS UART receive	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. If unused, keep this pin open.
PCM Interface					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
PCM_CLK	4	DO	PCM clock	$V_{OL}$ max = 0.45 V	
PCM_SYNC	5	DO	PCM data frame sync	V <sub>OH</sub> min = 1.35 V	1.9. V power demain
PCM_DIN	6	DI	PCM data input	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. If unused, keep these pins open.
PCM_DOUT	7	DO	PCM data output	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	
I2C Interface					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
I2C_SCL	40	OD	I2C serial clock (for external codec)	_	External pull-up resistor is required. 1.8 V only.
I2C_SDA	41	OD	I2C serial data (for external codec)		If unused, keep these pins open.
Antenna Interfa	ices				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
ANT_MAIN	60	AIO	Main antenna interface		50 $Ω$ impedance
ANT_GNSS	49	Al	GNSS antenna interface		50 $\Omega$ impedance. If unused, keep this pin open.
GPIO Interfaces	8				
Pin Name	Pin No.	I/O	Description	<b>DC Characteristics</b>	Comment



GPIO1 <sup>9</sup>	25				
GPIO2	26	_			
GPIO3	64	_			
GPIO4	65	_		$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	
GPIO5	66	DIO	General-purpose input/output	$V_{IL}min = -0.3 V$ $V_{IL}max = 0.6 V$	1.8 V power domain. If unused, keep this pin open.
GPIO6	85	_		$V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	орен.
GPIO7	86				
GPIO8	87				
GPIO9	88	_			
ADC Interfaces	•				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
ADC0	24	Al	General-purpose	Voltage range:	Do not use ADC0 and ADC1 simultaneously, as ADC1 connects directly to ADC0 inside
ADC1	2	Al	ADC interface	0.1–1.8 V	the module. If unused, keep these pins open.
Other Interface	S				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
W_DISABLE#	18	DI	Airplane mode control	$V_{IL}$ min = -0.3 V $V_{IL}$ max = 0.6 V $V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. Pulled up by default. When it is in low voltage level, the module can enter airplane mode. If unused, keep this pin open.
AP_READY	19	DI	Application processor ready	$V_{IL}$ min = -0.3 V - $V_{IL}$ max = 0.6 V	<ol> <li>1.8 V power domain.</li> <li>If unused, keep this pin open.</li> </ol>
USB_BOOT	75	DI	Force the module into download mode	$V_{IH}$ min = 1.2 V $V_{IH}$ max = 2.0 V	1.8 V power domain. Test point is recommended to be reserved.
GRFC Interface	es				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
GRFC1	83	DO	Generic RF controller	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	1.8 V power domain. If unused, keep this pin open.
GRFC2	84	DO	Generic RF controller	$V_{OL}$ max = 0.45 V $V_{OH}$ min = 1.35 V	BOOT_CONFIG. Do not pull it up before startup. 1.8 V power domain. If unused, keep this pin

<sup>&</sup>lt;sup>9</sup> This pin is GPIO by default, which can be multiplexed into fast shutdown interface (see *Chapter 3.4.3* for details).



		open.
RESERVED Pi	ns	
Pin Name	Pin No.	Comment
RESERVED	11–14, 16, 51, 56-57, 63, 76–78, 92–95, 97–99	Keep these pins open.

### **2.6. EVB Kit**

NetPrisma supplies an evaluation board (UMTS&LTE EVB) with accessories to develop and test the module. For more details, see *document [2]*.



# **3** Operating Characteristics

# 3.1. Operating Modes

Table 7: Operating Modes of PCUL11 Series Module

Mode	Details					
Full	Connected	The module connects to network. Its power consumption varies with the network setting and data transfer rate.				
Functionality Mode	Idle	The module remains registered on network, and is ready to send and receive data. In this mode, the software is active.				
Extended Idle Mode DRX (e-I-DRX)	of e-I-DRX for terminating data	The module and the network may negotiate over non-access stratum signaling the use of e-I-DRX for reducing power consumption, while being available for mobile terminating data and/or network originated procedures within a certain delay dependent on the DRX cycle value.				
Airplane Mode		AT+CFUN=4 or W_DISABLE# pin can set the module into airplane mode where the RF function is invalid.				
Minimum Functionality Mode		can set the module into a minimum functionality mode without removing ply. In this mode, both RF function and (U)SIM card are invalid.				
Sleep Mode		emains the ability to receive paging message, SMS and TCP/UDP data ork normally. In this mode, the power consumption reduces to a low				
Power OFF Mode	The module's power supply is shut down by its power management unit. In this mode, the software is inactive, the serial interfaces are inaccessible, while the operating voltage (connected to VBAT_RF and VBAT_BB) remains applied.					
Power Saving Mode (PSM)		r to power-off, but the module remains registered on the network and ed to re-attach or re-establish PDN connections. The power consumption inimized level.				

### **NOTE**

During e-I-DRX, it is recommended to use UART interface for data communication, as the use of USB interface increases power consumption.

# 3.2. Power Saving

### 3.2.1. Airplane Mode

When the module enters airplane mode, the RF function does not work, and all AT commands correlative with RF function are inaccessible. This mode can be set via the following methods.

#### Hardware:



W DISABLE# is pulled up by default. Driving it low makes the module enter airplane mode.

#### Software:

AT+CFUN=<fun> provides choice of the functionality level via setting <fun> to 0, 1 or 4.

- AT+CFUN=0: Minimum functionality mode. Both (U)SIM and RF functions are disabled.
- AT+CFUN=1: Full functionality mode (by default).
- AT+CFUN=4: Airplane mode. RF function is disabled.

#### **NOTE**

- 1. Airplane mode control via W\_DISABLE# is disabled in firmware by default. It can be enabled by AT+QCFG="airplanecontrol". For details of the command, see *document [4]*.
- 2. The execution of AT+CFUN (see *document [3]*) will not affect GNSS function.

#### 3.2.2. Power Saving Mode (PSM)

The module minimizes its power consumption through entering PSM. PSM mode is similar to power-off, but the module remains registered on the network and there is no need to re-attach or re-establish PDN connections. Therefore, the module in PSM cannot immediately respond to your requests.

When the module wants to use the PSM, it shall request an Active Time value during every Attach and TAU procedures. If the network supports PSM and accepts that the module uses PSM, the network confirms usage of PSM by allocating an Active Time value to the module. If the module wants to change the Active Time value, e.g., the module requests the value it wants in the TAU procedure.

If PSM is supported by the network, then it can be enabled via **AT+CPSMS**. See **document [3]** for details about the AT command.

Any of the following methods can wake up the module from PSM:

- Wake up the module from PSM through a rising edge on PON\_TRIG. (Recommended)
- Wake up the module by driving PWRKEY low.
- When the TAU timer expires, the module wakes up from PSM automatically.

#### 3.2.3. Extended Idle Mode DRX (e-I-DRX)

The module (UE) and the network may negotiate over non-access stratum signalling the use of e-I-DRX for reducing its power consumption, while being available for mobile terminating data and/or network originated procedures within a certain delay dependent on the DRX cycle value.

Applications that want to use e-I-DRX need to consider specific handling of mobile terminating services or data transfers, and in particular they need to consider the delay tolerance of mobile terminated data.

In order to negotiate the use of e-I-DRX, the UE requests e-I-DRX parameters during attach procedure and RAU/TAU procedure. The EPC may reject or accept the UE request for enabling e-I-DRX. In case the EPC accepts e-I-DRX, the EPC based on operator policies and, if available, the e-I-DRX cycle length value in the subscription data from the HSS, may also provide different values of the e-I-DRX parameters than what were requested by the UE. If the EPC accepts the use of e-I-DRX, the UE applies e-I-DRX based on the received e-I-DRX parameters. If the UE does not receive e-I-DRX parameters in the relevant accept message because the EPC rejected its request or because the request was received by EPC not supporting e-I-DRX, the UE shall apply its regular discontinuous reception.

If e-I-DRX is supported by the network, then it can be enabled by **AT+CEDRXS=1**. See **document [3]** for details about the AT command.



### 3.2.4. Sleep Mode

The module reduces its current consumption to a low level during sleep mode. The following sub-chapters describe the power saving procedure of the module.

#### 3.2.4.1. UART Interface Application

If the MCU communicates with the module via UART interface, the following preconditions enable the module to enter sleep mode.

- Execute AT+QSCLK=1 (see document [3]) to enable sleep mode.
- Drive MAIN\_DTR high.

The following figure shows the connection between the module and the MCU.

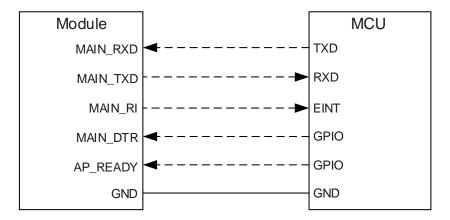


Figure 4: Sleep Mode Application via UART Interface

- When the module has a URC to report, MAIN\_RI will wake up the MCU. See Chapter 4.8 for details about MAIN\_RI behavior.
- Driving MAIN\_DTR low will wake up the module.
- AP\_READY detects the sleep state of the MCU (can be configured into high-level or low-level detection). See AT+QCFG="apready" in document [4] for details.

# 3.3. Power Supply

### 3.3.1. Power Supply Pins

PCUL11 series provides the following four VBAT pins for connection with an external power supply. There are two separate voltage domains for VBAT.

- Two VBAT\_RF pins for the module's RF part.
- Two VBAT\_BB pins for the module's baseband part.

#### Table 8: VBAT and GND Pins



\/DAT DE _ 50 6	52 52	52, 53 PI	Power supply for the	PCUL11-LD1	2.6	3.3	4.8	V
VBAT_RF 52, 53	00 FI	module's RF part	PCUL11-LD	3.3	3.8	4.3	V	
VBAT_BB 32, 33	22 22	00 00 DI	Power supply for the	PCUL11-LD1	2.6	3.3	4.8	V
	гі	module's baseband part	PCUL11-LD	3.3	3.8	4.3	V	
GND	3, 31, 48, 50, 54, 55, 58, 59, 61, 62, 67–74, 79–82, 89–91, 100–102							

### 3.3.2. Voltage Stability Requirements

#### PCUL11-LD1:

The power supply range of PCUL11-LD1 is 2.6–4.8 V. For every VBAT transition/re-insertion from 0 V, the minimum power supply voltage should be higher than 2.7 V. After the module starts up normally, the minimum safety voltage is 2.6 V. To ensure full functionality mode, the minimum power supply voltage should be higher than 2.8 V. Make sure that the input voltage never drops below 2.6 V.

#### PCUL11-LD:

The power supply range of PCUL11-LD is  $3.3-4.3~\rm{V}$ . Ensure the input voltage never drops below  $3.3~\rm{V}$ 

The following figure shows the voltage drop during burst transmission in 2G network of PCUL11-LD. The voltage drop is less in LTE Cat M1 and/or LTE Cat NB2 networks.

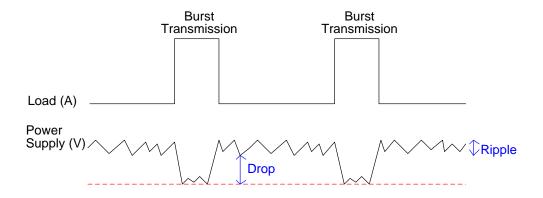


Figure 5: Power Supply Limits During Burst Transmission (PCUL11-LD)

To decrease voltage-drop, bypass capacitors of about 100  $\mu$ F with low ESR should be used, and multi-layer ceramic chip capacitor (MLCC) arrays should also be reserved due to their low ESR. Use seven ceramic capacitors (220 nF, 47 nF, 150 pF, 100 pF, 68 pF, 33 pF, 10 pF) to compose the MLCC array for VBAT\_BB, three ceramic capacitors (100 nF, 33 pF, 10 pF) to compose the MLCC array for VBAT\_RF, and place these capacitors close to VBAT pins. The main power supply from an external application has to be a single voltage source and can be expanded to two sub paths with star structure. The width of VBAT\_BB trace should be not less than 0.6 mm, and the width of VBAT\_RF trace should be not less than 2.7 mm. The longer the VBAT trace is, the wider it should be.

To get a stable power source, it is suggested to use two TVS components with low leakage current and suitable reverse stand-off voltage, and it is recommended to place them as close as possible to the VBAT pins.

In addition, route VBAT\_BB and VBAT\_RF traces in inner-layer of the PCB, and place a ferrite bead as close to VBAT\_BB as possible. Follow the criteria below for ferrite bead selection:



- Current rating ≥ 600 mA and low DC resistance to avoid voltage drop during instantaneous high power consumption.
- $\geq 800 \Omega$  impedance @ 700–960 MHz.

The following magnetic bead models are for reference: BLM18HE601SN1 and BLM18DN381SN1 are produced by Murata; MPZ1005A331E is produced by TDK.

The following figure shows the star structure of the power supply.

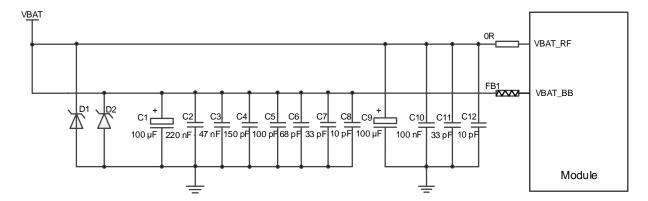


Figure 6: Star Structure of the Power Supply

If only LTE Cat M1 and/or Cat NB2 networks are used, it is recommended to select a DC-DC converter chip or LDO chip with ultra-low leakage current and current output not less than 1.0 A for the power supply design.

If LTE Cat M1, Cat NB2, and EGPRS networks are all used, the current output of DC-DC converter chip or LDO chip should exceed 2.7 A and power supply chips with low leakage current should be adopted because the module needs higher current in GSM network data transmission. Only PCUL11-LD3 support GSM network. For more details about supported bands of each module model, see *Table 3*.

#### 3.3.3. Power Supply Voltage Monitoring

AT+CBC monitors the VBAT\_BB voltage value. For more details, see document [3].

#### 3.4. Turn On and Turn Off

#### 3.4.1. Turn On with PWRKEY

Table 9: Pin Definition of PWRKEY

Pin Name	Pin No.	I/O	Description	Comment
PWRKEY	15	DI	Turn on/off the module	Never pull down PWRKEY to GND permanently. The output voltage is 1.5 V because of the voltage drop inside the chipset.

The module can be turned on by driving PWRKEY low for 500–1000 ms. It is recommended to use an open drain/collector driver to control the PWRKEY.

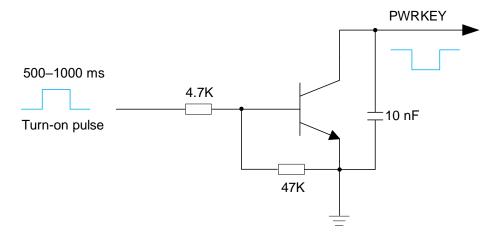


Figure 7: Turn On the Module with a Driver Circuit

Another way to control the PWRKEY is using a push button. As electrostatic strike may be generated from the finger touching when the button is pressed, a TVS component is indispensable to be placed near the button for ESD protection. A reference circuit is illustrated in the following figure.

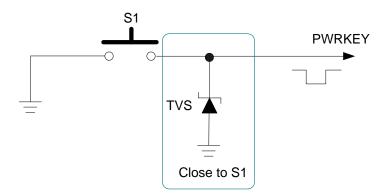


Figure 8: Turn On the Module with a Push Button

The turn-on timing is illustrated in the following figure.

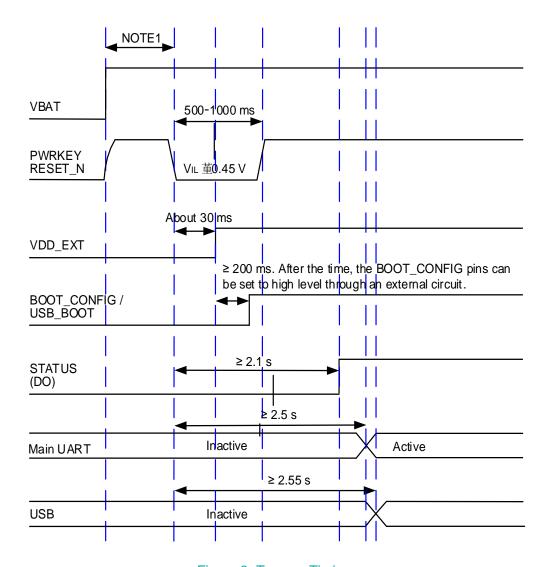


Figure 9: Turn-on Timing

#### **NOTE**

- 1. Ensure that VBAT is stable before pulling down PWRKEY and keep the interval not less than 30 ms.
- 2. The output voltage of PWRKEY is 1.5 V because of the voltage drop inside the chipset. Due to platform limitations, the chipset has integrated the reset function into PWRKEY. Therefore, never pull down PWRKEY to GND permanently.

#### 3.4.2.

### 3.4.2. Turn Off

Either of the following methods can be used to turn off the module:

- with PWRKEY
- with AT+QPOWD



#### 3.4.2.1. Turn Off with PWRKEY

Driving PWRKEY low for 650–1500 ms and then releasing it, the module will execute turn-off procedure.

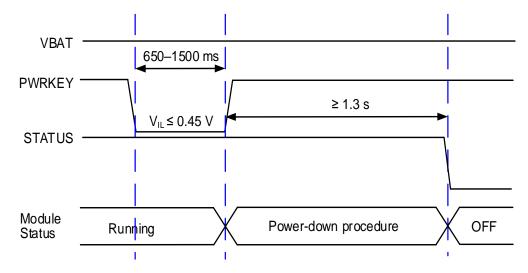


Figure 10: Turn-off Timing

#### 3.4.2.2. Turn Off with AT Command

It is also a safe way to execute **AT+QPOWD** to turn off the module, which is similar to turning off the module with PWRKEY. See *document [3]* for details about **AT+QPOWD**.

#### **NOTE**

- 1. To avoid corrupting the data in the internal flash, do not switch off the power supply when the module is working. Only after the module is shut down with PWRKEY, fast shutdown function or AT command can the power supply be cut off.
- 2. While turning off the module with AT command, keep PWRKEY at high level after the execution of turn-off command, otherwise the module will be turned on again after it turns off.
- 3. It is recommended to judge whether the module has been shut down based on the state of STATUS.

#### 3.4.3.

#### 3.4.3. Fast Shutdown

The module supports fast shutdown function through GPIO1 (pin 25). When the pin detects a falling edge, the module powers off within 100 ms without damaging the file system, but the writing data may be lost. Fast shutdown is disabled by default.

For more details, see AT+QCFG="fast/poweroff" in document [4].

Table 10: Pin Definition of Fast Shutdown Interface



Pin Name	Pin No.	I/O	Description	Comment
GPIO1 <sup>10</sup>	25	DI	When the pin detects a falling edge, the module powers off	Falling-edge triggered. Pulled-up by default. 1.8 V power domain.

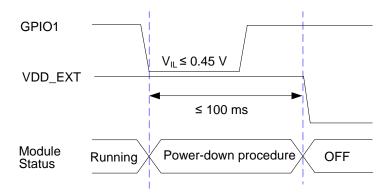


Figure 11: Fast Shutdown Timing

## 3.5. RESET\_N

RESET\_N works to reset the module. Due to platform limitations, the chipset has integrated the reset function into PWRKEY, and RESET\_N connects directly to PWRKEY inside the module.

Table 11: Pin Definition of RESET\_N

Pin Name	Pin No.	I/O	Description	Comment
RESET_N	17	DI	Reset the module	Multiplexed from PWRKEY. A test point is recommended to be reserved if unused.

The module can be reset by driving RESET\_N low for 2–3.8 s.

The recommended circuit is similar to the PWRKEY control circuit. An open drain/collector driver or a button can be used to control RESET\_N.

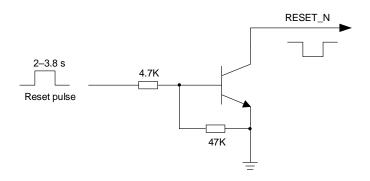


Figure 12: Reference Design of RESET\_N with a Driver Circuit

Another way to control the RESET\_N is to use a push button.

<sup>&</sup>lt;sup>10</sup> Pin 25 is a general-purpose IO by default. It can be multiplexed into fast shutdown interface with **AT+QCFG="fast/poweroff"**.

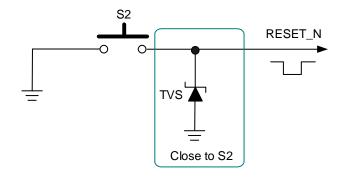


Figure 13: Reference Design of RESET\_N with a Push Button

The reset timing is illustrated in the following figure.

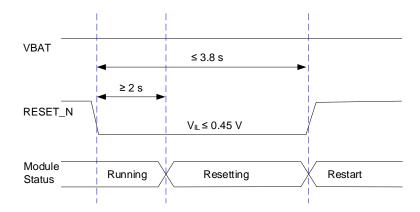


Figure 14: Reset Timing

#### **NOTE**

Ensure that there is no large capacitance on RESET\_N.



# 4 Application Interfaces

# 4.1. PON\_TRIG Interface

The module provides one PON\_TRIG pin which is used to wake up the module from PSM. When the pin detects a rising edge and keeps at high level for at least 30 ms, the module wakes up from PSM.

Table 12: Pin Definition of PON\_TRIG Interface

Pin Name	Pin No.	I/O	Description	Comment
PON_TRIG	96	DI	Wake up the module from PSM	Rising-edge triggered. Pulled-down by default. 1.8 V power domain. If unused, keep this pin open.

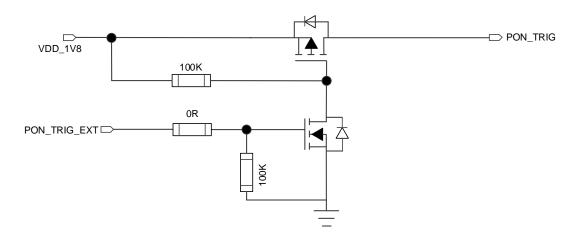


Figure 15: Reference Design of PON\_TRIG

#### **NOTE**

VDD\_1V8 is provided by an external LDO.

### 4.2.

# 4.2. (U)SIM Interface

The module supports 1.8 V (U)SIM card only. The (U)SIM interface circuit meets ETSI and IMT-2000 requirements.

#### Table 13: Pin Definition of (U)SIM Interface



Pin Name	Pin No.	I/O	Description	Comment
USIM_DET	42	DI	(U)SIM card hot-plug detect	1.8 V power domain. If unused, keep this pin open.
USIM_VDD	43	РО	(U)SIM card power supply	Only 1.8 V (U)SIM card is supported.
USIM_RST	44	DO	(U)SIM card reset	
USIM_DATA	45	DIO	(U)SIM card data	1.8 V power domain.
USIM_CLK	46	DO	(U)SIM card clock	
USIM_GND	47	-	Specified ground for (U)SIM card	

The module supports (U)SIM card hot-plug via the USIM\_DET pin, and both high-level and low-level detections are supported. The function is disabled by default, and see **AT+QSIMDET** in **document [3]** for more details.

The following figure shows a reference design of (U)SIM interface with an 8-pin (U)SIM card connector.

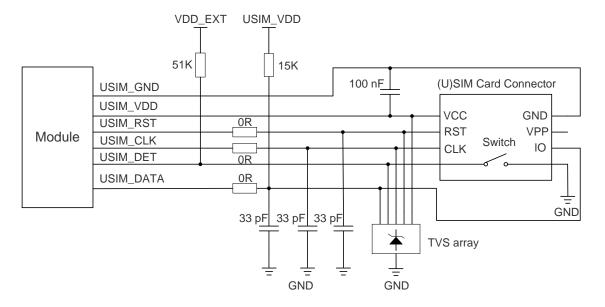


Figure 16: Reference Design of (U)SIM Interface with a 8-Pin (U)SIM Card Connector

If (U)SIM card detection function is not needed, keep USIM\_DET unconnected. A reference circuit for (U)SIM interface with a 6-pin (U)SIM card connector is illustrated in the following figure.

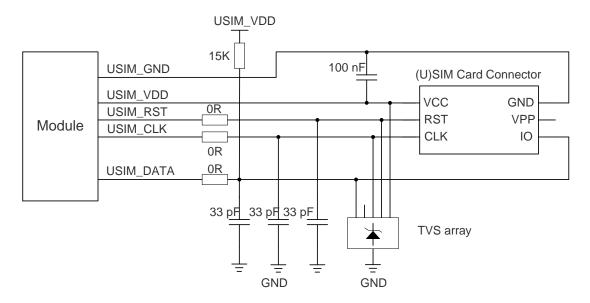


Figure 17: Reference Design of (U)SIM Interface with a 6-Pin (U)SIM Card Connector

To enhance the reliability and availability of the (U)SIM card in applications, follow the criteria below in (U)SIM circuit design:

- Keep the placement of (U)SIM card connector as close to the module as possible. Keep the trace length as short as possible, at most 200 mm.
- Keep (U)SIM card signals away from RF and power supply traces.
- Assure the ground trace between the module and the (U)SIM card connector short and wide. Keep
  the trace width of ground and USIM\_VDD not less than 0.5 mm to maintain the same electric
  potential. Make sure the bypass capacitor between USIM\_VDD and USIM\_GND is less than 1 μF,
  and place it as close to (U)SIM card connector as possible. If the system ground plane is complete,
  USIM\_GND can be connected to the system ground directly.
- To avoid crosstalk between USIM\_DATA and USIM\_CLK, keep them away from each other and shield them with surrounded ground. USIM\_RST should also be surrounded with ground.
- To offer good ESD protection, it is recommended to add a TVS array with parasitic capacitance not exceeding 15 pF. To facilitate debugging, it is recommended to reserve series resistors for the (U)SIM signals of the module. The 33 pF capacitors are used for RF filtering interference. Note that the (U)SIM peripheral circuit should be close to the (U)SIM card connector.
- The pull-up resistor on USIM\_DATA trace can improve anti-jamming capability when long layout trace and sensitive occasion are applied, and should be placed close to the (U)SIM card connector.

#### **NOTE**

eSIM\* function is optional. If eSIM is selected, then the external (U)SIM card cannot be used simultaneously.

#### 4.3. USB Interface



The module provides one integrated Universal Serial Bus (USB) interface which complies with the USB 2.0 specification and supports operation at low-speed (1.5 Mbps), full-speed (12 Mbps) and high-speed (480 Mbps) modes.

The USB interface is used for AT command communication, data transmission 11, GNSS NMEA sentences output, software debugging and firmware upgrade. The following table shows the pin definition of USB interface.

Table 14: Pin Definition of USB Interface

Pin Name	Pin No.	I/O	Description	Comment
USB_VBUS	8	Al	USB connection detect	Typical 5.0 V. Test point must be reserved.
USB_DP	9	AIO	USB differential data (+)	Require differential impedance of $90 \Omega$ .
USB_DM	10	AIO	USB differential data (-)	Test point must be reserved.
GND	3	-	Ground	

For more details about USB 2.0 specification, visit https://www.usb.org/home.

The USB interface is recommended to be reserved for firmware upgrade and software debugging in application designs. The following figure shows a reference design of USB interface.

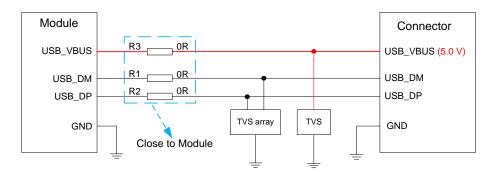


Figure 18: Reference Design of USB Interface

To ensure the integrity of USB data trace signal, resistors should be placed close to the module, and also these resistors should be placed close to each other. The extra stubs of trace must be as short as possible.

To meet USB 2.0 specification, comply with the following principles while designing the USB interface.

- It is important to route the USB signal traces as differential pairs with ground surrounded. The impedance of USB differential trace is 90  $\Omega$ .
- Do not route signal traces under crystals, oscillators, magnetic devices and RF signal traces. It is important to route the USB differential traces in inner-layer of the PCB, and surround the traces with ground on that layer and with ground planes above and below.
- Junction capacitance of the ESD protection components might cause influences on USB data traces, so pay attention to the selection of the components. Typically, the stray capacitance should be less than 2 pF.
- Keep TVS components as close to the USB connector as possible.

<sup>&</sup>lt;sup>11</sup> It is not recommended to use USB for data communication, as this will increase the power consumption.



The USB interface supports slave mode only.

#### 4.4. UART Interfaces

The module provides three UART interfaces: the main UART interface, debug UART interface and GNSS UART interface. Their features are outlined below:

- The main UART interface supports 9600, 19200, 38400, 57600, 115200, 230400, 460800 and 921600, 2000000, 2900000, 3000000, 3200000, 3686400, 4000000 bps baud rates, and the default baud rate is 115200 bps. It is used for data transmission and AT command communication, and supports RTS and CTS hardware flow control. The default frame format is 8N1 (8 data bits, no parity, 1 stop bit).
- The debug UART interface supports a fixed baud rate of 115200 bps, and is used for software debugging and log output.
- The GNSS UART interface supports 115200 bps baud rate by default, and is used for GNSS data and NMEA sentences output.

Table 15: Pin Definition of Main UART Interface

Pin Name	Pin No.	I/O	Description	Comment
MAIN_DTR	30	DI	Main UART data terminal ready	401/
MAIN_RXD	34	DI	Main UART receive	<ul><li>1.8 V power domain.</li><li>If unused, keep these pins</li><li>open.</li></ul>
MAIN_TXD	35	DO	Main UART transmit	- орен.
MAIN_CTS	36	DO	Clear to send signal from the module	Connect to the MCU's CTS. 1.8 V power domain. If unused, keep the pin open.
MAIN_RTS	37	DI	Request to send signal to the module	Connect to the MCU's RTS. 1.8 V power domain. If unused, keep the pin open.
MAIN_DCD	38	DO	Main UART data carrier detect	1.8 V power domain.
MAIN_RI	39	DO	Main UART ring indication	If unused, keep these pins open.

#### **NOTE**

AT+IPR can be used to set the baud rate of the main UART interface, and AT+IFC can be used to enable/disable the hardware flow control (the function is disabled by default). See *document [3]* for



more details about these AT commands.

Table 16: Pin Definition of Debug UART Interface

Pin Name	Pin No.	I/O	Description	Comment
DBG_RXD	22	DI	Debug UART receive	1.8 V power domain.
DBG_TXD	23	DO	Debug UART transmit	If unused, keep these pins open. Test points must be reserved.

Table 17: Pin Definition of GNSS UART Interface

Pin Name	Pin No.	I/O	Description	Comment
GNSS_TXD	27	DO	GNSS UART transmit	BOOT_CONFIG. Do not pull it up before startup. 1.8 V power domain. If unused, keep this pin open.
GNSS_RXD	28	DI	GNSS UART receive	1.8 V power domain. If unused, keep this pin open.

#### **NOTE**

GNSS\_TXD is a BOOT\_CONFIG pin. Never pull it up before startup, otherwise the module cannot power up normally.

The module provides 1.8 V UART interface. A voltage-level translator should be used if your application is equipped with a 3.3 V UART interface. The voltage-level translator TXS0108EPWR provided by Texas Instruments is recommended.

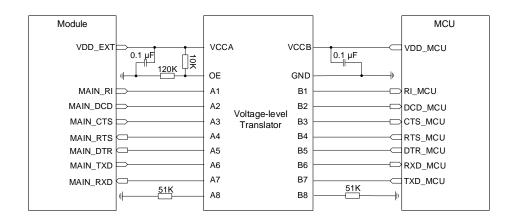


Figure 19: Main UART Interface Reference Design (IC Solution)



Visit <a href="http://www.ti.com/">http://www.ti.com/</a> for more information.

Another example with transistor translation circuit is shown as below. For the design of circuits shown in dotted lines, refer to the solid lines, but pay attention to the direction of connection.

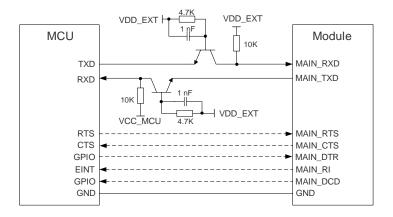


Figure 20: Main UART Interface Reference Design (Transistor Solution)

#### NOTE

- 1. Transistor circuit solution is not suitable for applications with high baud rates exceeding 460 kbps.
- 2. Please note that the module's CTS is connected to the MCU's CTS, and the module's RTS is connected to the MCU's RTS.
- 3. The level-shifting circuits (<u>Figure 19</u> and Figure 20) take the main UART as an example. The circuits of the debug UART and the GNSS UART are connected in the same way as the main UART.
- 4. To increase the stability of UART communication, it is recommended to add UART hardware flow control design.

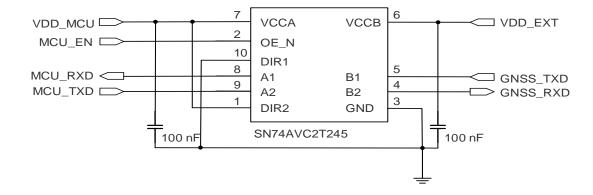


Figure 21: GNSS UART Interface Reference Design (IC Solution Without Internal Pull-up)



GNSS\_TXD is a BOOT\_CONFIG pin (pin 27), therefore the IC solution with pull-up circuit or transistor/MOSFET circuit is not applicable. It is recommended to adopt an IC solution without internal pull-up.

#### 4.5. PCM and I2C Interfaces

The module provides one Pulse Code Modulation (PCM) digital interface and one inter-integrated circuit (I2C) interface.

The following table shows the pin definition of the two interfaces which can be applied to audio codec design.

Table 18: Pin Definition of PCM and I2C Interfaces

Pin Name	Pin No.	I/O	Description	Comment	
PCM_CLK	4	DO	PCM clock		
PCM_SYNC	5	DO	PCM data frame sync	1.8 V power domain.	
PCM_DIN	6	DI	PCM data input	If unused, keep these pins open.	
PCM_DOUT	7	DO	PCM data output		
I2C_SCL	40	OD	I2C serial clock (for external codec)	External pull-up resistors are	
I2C_SDA	41	OD	I2C serial data (for external codec)	required. 1.8 V only. If unused, keep these pins open.	

The following figure shows a reference design of PCM and I2C interfaces with an external codec IC.

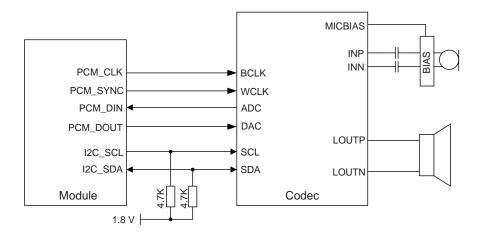


Figure 22: Reference Design of PCM and I2C Application with Audio Codec

#### 4.6. Network Status Indication



The module provides one network status indication pin (NET\_STATUS). The pin is used to drive a network status indication LED. The following tables describe the pin definition and logic level changes of NET\_STATUS in different network activity status.

Table 19: Pin Definition of NET\_STATUS

Pin Name	Pin No.	I/O	Description	Comment
NET_STATUS	21	DO	Indicates the module's network activity status	1.8 V power domain. If unused, keep this pin open.

#### Table 20: Operating State of NET\_STATUS

Pin Name	Logic Level Changes	Network Status
NET_STATUS	Blink slowly (200 ms High/1800 ms Low)	Network searching
	Blink slowly (1800 ms High/200 ms Low)	Idle
	Blink quickly (125 ms High/125 ms Low)	Data transfer is ongoing

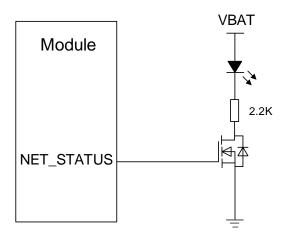


Figure 23: Reference Design of the Network Status Indicator

#### 4.7. STATUS

The STATUS pin indicates the operation status of the module. It outputs high level when the module powers up.

Table 21: Pin Definition of STATUS

Pin Name	Pin No.	I/O	Description	Comment
STATUS	20	DO	Indicates the module's operation status	1.8 V power domain. If unused, keep this pin open.

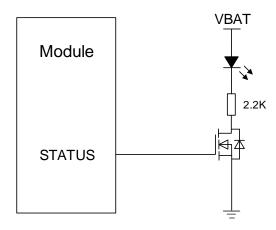


Figure 24: Reference Design of STATUS

### 4.8. MAIN\_RI

**AT+QCFG="risignaltype","physical"** can configure MAIN\_RI behavior. No matter on which port the URC is presented, the URC will trigger the behavior of MAIN\_RI.

Table 22: Default Behaviours of MAIN\_RI

State	Response
Idle	MAIN_RI keeps in high level.
URC	MAIN_RI outputs 120 ms low pulse when a new URC returns.

The default MAIN\_RI pin behaviors can be configured flexibly by AT+QCFG="urc/ri/ring". For more details about AT+QCFG, see document [4].

#### **NOTE**

A URC can be output from the UART interface through configuration via **AT+QURCCFG**. For details about the AT command, see *document* [3].

#### 4.9.

# 4.9. USB\_BOOT

PCUL11 series provides a USB\_BOOT pin. During development or factory production, USB\_BOOT can force the module to boot from USB interface for firmware upgrade.

#### Table 23: Pin Definition of USB BOOT Interface



Pin Name	Pin No.	I/O	Description	Comment
USB_BOOT	75	DI	Force the module into download mode	1.8 V power domain. Active high. If unused, keep it open.

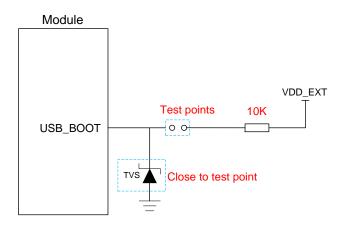


Figure 25: Reference Design of USB\_BOOT Interface

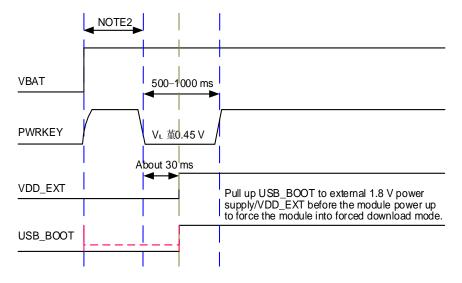


Figure 26: Timing for Turning on the Module with USB\_BOOT

- 1. It is recommended to reserve the above circuit design during application design.
- 2. Ensure that VBAT is stable before pulling down PWRKEY. It is recommended that the time difference between powering up VBAT and pulling down PWRKEY is not less than 30 ms.
- When using MCU to control the module entering emergency download mode, follow the above timing. Connecting the test points as shown in Figure 25 can manually force the module to enter download mode.



#### 4.10. ADC Interfaces

The module provides two analog-to-digital converter (ADC) interfaces but only one ADC interface can be used at a time since ADC1 connects directly to ADC0 inside the module.

AT+QADC=0 can be used to read the voltage value on the ADC being used. For more details about the AT command, see *document* [3].

To improve the accuracy of ADC voltage values, the traces of ADC should be surrounded with ground.

Table 24: Pin Definition of ADC Interfaces

Pin Name	Pin No.	I/O	Description	Comment
ADC0	24	Al	General-purpose ADC interface	Do not use ADC0 and ADC1
ADC1	2	Al		simultaneously.

#### Table 25: Characteristics of ADC Interfaces

Parameter	Min.	Тур.	Max.	Unit
Input Voltage Range	0.1	-	1.8	V
Resolution (LSB)	-	64.879	-	μV
Analog Bandwidth	-	500	-	kHz
Sample Clock	-	4.8	-	MHz
Input Resistance	10	-	-	MΩ

#### **NOTE**

- 1. It is prohibited to supply any voltage to ADC pin when VBAT is removed.
- 2. It is recommended to use resistor divider circuit for ADC application, and the divider resistor accuracy should be at least 1 %.
- 3. Do not use ADC0 and ADC1 simultaneously, as ADC1 connects directly to ADC0 inside the module.



#### 4.11. GPIO Interfaces

The module provides nine general-purpose input and output (GPIO) interfaces. AT+QCFG="gpio" can configure the status of GPIO pins. For more details about the AT command, see *document [4]*.

Table 26: Pin Definition of GPIO Interfaces

Pin Name	Pin No.	I/O	Description	Comment
GPIO1 12	25			
GPIO2	26			
GPIO3	64		DIO General-purpose input/output	1.8 V power domain. If unused, keep these pins open.
GPIO4	65			
GPIO5	66	DIO		
GPIO6	85			
GPIO7	86			
GPIO8	87			
GPIO9	88			

#### 4.12. GRFC Interfaces

The module provides two generic RF control interfaces for the control of external antenna tuners.

Table 27: Pin Definition of GRFC Interfaces

Pin Name	Pin No.	I/O	Description	Comments
GRFC1	83		Generic RF controller	1.8 V power domain. If unused, keep this pin open.
GRFC2	84	DO		BOOT_CONFIG. Do not pull it up before startup. 1.8 V power domain.

Table 28: Truth Table of GRFC Interfaces

GRFC1 Level	GRFC2 Level	Frequency Range (MHz)	Band
Low	Low	880–2180	B1, B2, B3, B4, B8, B25, B66
Low	High	791–894	B5, B18, B19, B20, B26, B27
High	Low	698–803	B12, B13, B28, B85

 $<sup>^{12}</sup>$  Pin 25 is a general-purpose IO by default. It can be multiplexed into fast shutdown interface with AT+QCFG="fast/poweroff".



High	High	617–698	B71	



# 5 GNSS

# 5.1. General Description

The module includes a fully integrated global navigation satellite system solution that supports GPS, GLONASS, BDS, Galileo and QZSS.

The module supports standard NMEA 0183 protocol, and outputs NMEA sentences at 1 Hz data update rate via USB interface by default.

By default, PCUL11 GNSS engine is switched off. It has to be switched on via AT command. The module does not support concurrent operation of WWAN and GNSS. For more details about GNSS engine technology and configurations, see *document [1]*.

#### 5.2. GNSS Performance

Table 29: GNSS Performance

Parameter	Description	Conditions	Тур.	Unit
	Acquisition	Autonomous	-146	dBm
Sensitivity	Reacquisition	Autonomous	-157	dBm
	Tracking	Autonomous	-157	dBm
	Cold start @ anan aku	Autonomous	31.01	S
	Cold start @ open sky	XTRA enabled	10.4	S
TTFF	Marine start @ anar als	Autonomous	30.58	S
IIFF	Warm start @ open sky	XTRA enabled	1.53	S
	Hot start @ apon alay	Autonomous	1.6	S
	Hot start @ open sky	XTRA enabled	1.5	S
Accuracy	CEP-50	Autonomous @ open sky	2.5	m

#### NOTE

1. Tracking sensitivity: the minimum GNSS signal power at which the module can maintain lock (keep



- positioning for at least 3 minutes continuously).
- 2. Reacquisition sensitivity: the minimum GNSS signal power required for the module to maintain lock within 3 minutes after loss of lock.
- 3. Acquisition sensitivity: the minimum GNSS signal power at which the module can fix position successfully within 3 minutes after executing cold start command.

### 5.3. Layout Guidelines

The following layout guidelines should be taken into account in application designs.

- Maximize the distance between GNSS antenna and main antenna.
- Digital circuits such as (U)SIM card, USB interface, camera module, display connector and SD card should be away from the antennas.
- Use ground vias around the GNSS trace and sensitive analog signal traces to provide coplanar isolation and protection.
- Keep 50  $\Omega$  characteristic impedance for ANT\_GNSS trace.

See *Chapter 6* for GNSS antenna reference design and antenna installation information.



# 6 Antenna Interfaces

Appropriate antenna type and design should be used with matched antenna parameters according to specific application. It is required to perform a comprehensive functional test for the RF design before mass production of terminal products. The entire content of this chapter is provided for illustration only. Analysis, evaluation and determination are still necessary when designing target products.

The module includes a main antenna interface and a GNSS antenna interface. The impedance of antenna interfaces is 50  $\Omega$ .

#### 6.1. Main Antenna Interface

#### 6.1.1. Pin Definition

Table 30: Pin Definition of Main Antenna Interface

Pin Name	Pin No.	I/O	Description	Comment
ANT_MAIN	60	AIO	Main antenna interface	50 $Ω$ impedance

#### 6.1.2. Operating Frequency

Table 31: Operating Frequency of PCUL11 Series Module

3GPP Band	Transmit	Receive	Unit
GSM850	824–849	869–894	MHz
EGSM900	880–915	925–960	MHz
DCS1800	1710–1785	1805–1880	MHz
PCS1900	1850–1910	1930–1990	MHz
LTE HD-FDD B1	1920–1980	2110–2170	MHz
LTE HD-FDD B2	1850–1910	1930–1990	MHz
LTE HD-FDD B3	1710–1785	1805–1880	MHz
LTE HD-FDD B4	1710–1755	2110–2155	MHz
LTE HD-FDD B5	824–849	869–894	MHz
LTE HD-FDD B8	880–915	925–960	MHz



LTE HD-FDD B12	699–716	729–746	MHz
LTE HD-FDD B13	777–787	746–756	MHz
LTE HD-FDD B18	815–830	860–875	MHz
LTE HD-FDD B19	830–845	875–890	MHz
LTE HD-FDD B20	832–862	791–821	MHz
LTE HD-FDD B25	1850–1915	1930–1995	MHz
LTE HD-FDD B26	814–849	859–894	MHz
LTE HD-FDD B27	807–824	852–869	MHz
LTE HD-FDD B28	703–748	758–803	MHz
LTE HD-FDD B66	1710–1780	2110–2180	MHz
LTE HD-FDD B71	663–698	617–652	MHz
LTE HD-FDD B85	698–716	728–746	MHz

- 1. LTE HD-FDD B26 and B27 are supported by Cat M1 only.
- 2. LTE HD-FDD B71 is supported by Cat NB2 only.

#### 6.1.3.

#### 6.1.3. Reference Design

A reference design of main antenna interface is shown as below. It is recommended to reserve a  $\pi$ -type matching circuit for better RF performance, and the  $\pi$ -type matching components (R1/C1/C2) should be placed as close to the antenna as possible. The capacitors are not mounted by default.

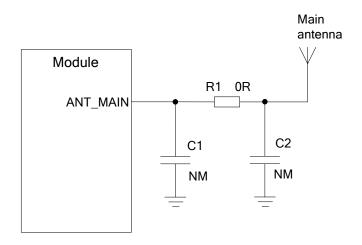


Figure 27: Reference Design of Main Antenna Interface



# 6.2. GNSS Antenna Interface

#### 6.2.1. Pin Definition

Table 32: Pin Definition of GNSS Antenna Interface

Pin Name	Pin No.	I/O	Description	Comment
ANT_GNSS	49	AI	GNSS antenna interface	50 $\Omega$ impedance. If unused, keep this pin open.

# 6.2.2. GNSS Operating Frequency

Table 33: GNSS Operating Frequency

GNSS Constellation Type	Frequency	Unit
GPS	1575.42 ±1.023	MHz
GLONASS	1597.5–1605.8	MHz
Galileo	1575.42 ±2.046	MHz
BDS	1561.098 ±2.046	MHz
QZSS	1575.42 ±1.023	MHz

# 6.2.3. Reference Design

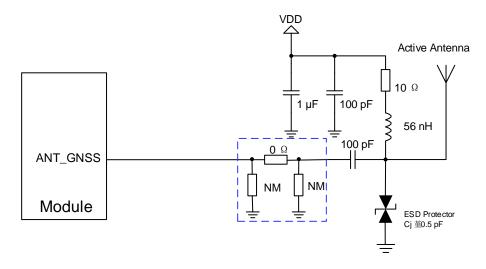


Figure 28: Reference Design of GNSS Antenna Interface



- 1. An external LDO can be selected to supply power according to the active antenna requirement.
- 2. If the module is designed with a passive antenna, then the VDD circuit is not needed.

# 6.3. RF Routing Guidelines

For your PCB, the characteristic impedance of all RF traces should be controlled to  $50~\Omega$ . The impedance of the RF traces is usually determined by the trace width (W), the materials' dielectric constant, the height from the reference ground to the signal layer (H), and the spacing between RF traces and grounds (S). Microstrip or coplanar waveguide is typically used in RF layout to control characteristic impedance. The following are reference designs of microstrip or coplanar waveguide with different PCB structures.

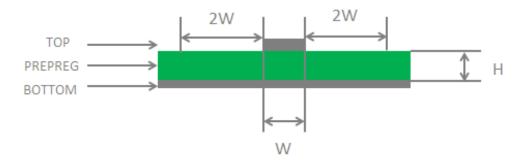


Figure 29: Microstrip Design on a 2-layer PCB

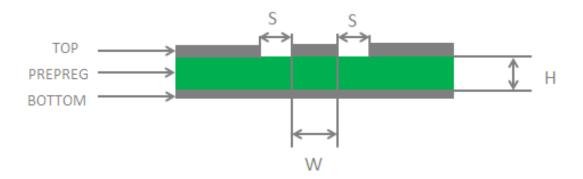


Figure 30: Coplanar Waveguide Design on a 2-layer PCB

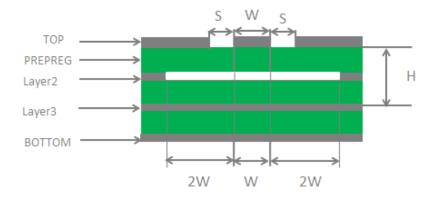


Figure 31: Coplanar Waveguide Design on a 4-layer PCB (Layer 3 as Reference Ground)

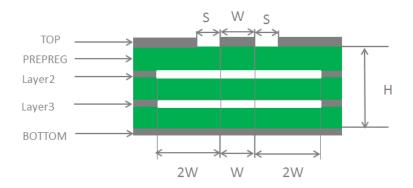


Figure 32: Coplanar Waveguide Design on a 4-layer PCB (Layer 4 as Reference Ground)

To ensure RF performance and reliability, the following principles should be complied with in RF layout design:

- Use an impedance simulation tool to accurately control the characteristic impedance of RF traces to  $50 \Omega$ .
- The GND pins adjacent to RF pins should not be designed as thermal relief pads, and should be fully connected to ground.
- The distance between the RF pins and the RF connector should be as short as possible, and all the right-angle traces should be changed to curved ones. The recommended trace angle is 135°.
- There should be clearance under the signal pin of the antenna connector or solder joint.
- The reference ground of RF traces should be complete. Meanwhile, adding some ground vias around RF traces and the reference ground could help to improve RF performance. The distance between the ground vias and RF traces should be at least twice the width of RF signal traces (2 x W).
- Keep RF traces away from interference sources, and avoid intersection and paralleling between traces on adjacent layers.

For more details about RF layout, see document [5].



# 6.4. Antenna Installation

### 6.4.1. Requirements for Antenna Design

Table 34: Requirements for Antenna Design

Antenna Type	Requirements
GNSS <sup>13</sup>	Frequency range: 1559–1609 MHz Polarization: RHCP or linear VSWR: ≤ 2 (Typ.)
	For passive antenna usage: Passive antenna gain: > 0 dBi
	For active antenna usage: Active antenna noise figure: < 1.5 dB (Typ.) Active antenna embedded LNA gain: < 17 dB (Typ.)
Cellular	VSWR: $\leq$ 2 Efficiency: > 30 % Max. Input Power: 50 W Input Impedance: 50 $\Omega$ Cable Insertion Loss:
	• <1 dB: LB (<1 GHz)
	• < 1.5 dB: MB (1–2.3 GHz)

 $<sup>^{13}</sup>$  It is recommended to use a passive GNSS antenna when LTE HD-FDD B13 is supported, as the use of active antenna may generate harmonics which will affect the GNSS performance.



#### 6.4.2. RF Connector Recommendation

If RF connector is used for antenna connection, it is recommended to use the U.FL-R-SMT connectors provided by Hirose.

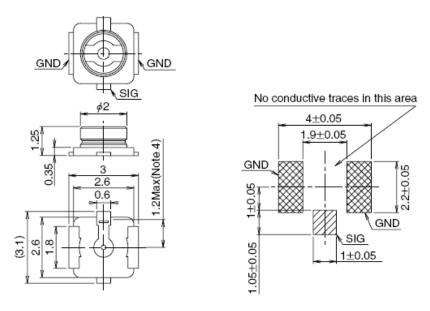


Figure 33: Dimensions of the Receptacle (Unit: mm)

U.FL-LP series mated plugs listed in the following figure can be used to match the U.FL-R-SMT.

	U.FL-LP-040	U.FL-LP-066	U.FL-LP(V)-040	U.FL-LP-062	U.FL-LP-088
Part No.	3	86	3.4	87	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5
Mated Height	2.5mm Max. (2.4mm Nom.)	2.5mm Max. (2.4mm Nom.)	2.0mm Max. (1.9mm Nom.)	2.4mm Max. (2.3mm Nom.)	2.4mm Max. (2.3mm Nom.)
Applicable cable	Dia. 0.81mm Coaxial cable	Dia. 1.13mm and Dia. 1.32mm Coaxial cable	Dia. 0.81mm Coaxial cable	Dia. 1mm Coaxial cable	Dia. 1.37mm Coaxial cable
Weight (mg)	53.7	59.1	34.8	45.5	71.7
RoHS			YES		

Figure 34: Specifications of Mated Plugs

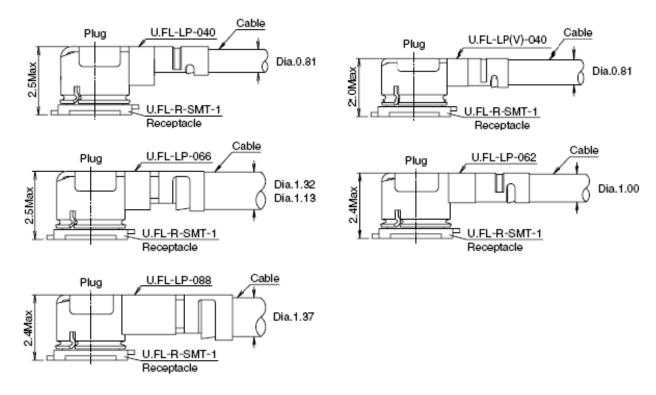


Figure 35: Space Factor of Mated Connectors (Unit: mm)

For more details, visit <a href="http://www.hirose.com">http://www.hirose.com</a>.



# 7 Electrical Characteristics and Reliability

# 7.1. Absolute Maximum Ratings

Absolute maximum ratings for power supply and voltage on digital and analog pins of the module are listed in the following table.

Table 35: Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
VBAT_BB	-0.5	6.0	V
VBAT_RF	-0.3	6.0	V
USB_VBUS	-0.3	5.5	V
Voltage at Digital Pins	-0.3	2.09	V

# 7.2. Power Supply Ratings

Table 36: Power Supply Ratings

Parameter	Description	Conditions	Model	Min.	Тур.	Max.	Unit
VBAT	VBAT_BB/	The actual input voltages must be	PCUL11-LD1	2.6 14	3.3	4.8	V
	VBAT_RF	kept between the minimum and the maximum values.	PCUL11-LD	3.3	3.8	4.3	V
I <sub>VBAT</sub>	Peak power consumption (during transmission slot)	At maximum power control level	PCUL11-LD	-	1.8	2.7	Α
	Peak power consumption	In LTE Cat M1 and/or Cat NB2 transmission modes	PCUL11-LD1	-	0.8	1.0	Α
USB_VBUS	USB connection detection		PCUL11 series	4.0	5.0	5.25	V

<sup>&</sup>lt;sup>14</sup> For every VBAT transition/re-insertion from 0 V, the minimum power supply voltage should be higher than 2.7 V. After the module starts up normally, the minimum safety voltage is 2.6 V. To ensure full functionality mode, the minimum power supply voltage should be higher than 2.8 V.



# 7.3. Operating and Storage Temperatures

Table 37: Operating and Storage Temperatures

Parameter	Min.	Тур.	Max.	Unit
Operating Temperature Range <sup>15</sup>	-35	+25	+75	°C
Extended Temperature Range <sup>16</sup>	-40	-	+85	°C
Storage Temperature Range	-40	-	+90	°C

# 7.4. Power Consumption

# 7.4.1. PCUL11-LD1 Power Consumption

Table 38: PCUL11-LD1 Power Consumption (3.3 V Power Supply, Room Temperature)

Description	Conditions	Average	Unit
Leakage	Power-off @ USB and UART disconnected	14	μΑ
PSM <sup>17</sup>	Power Saving Mode	4	μΑ
Rock Bottom	AT+CFUN=0 @ Sleep mode	0.53	mA
Sleep Mode	LTE Cat M1 DRX = 1.28 s	1.7	mA
(USB disconnected)	LTE Cat M1 e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s	0.577	mA
Idle Mode (USB disconnected)	LTE Cat M1 DRX = 1.28 s	20	mA

The module's USB and UART are disconnected and GSM network (if available) does not support PSM.

<sup>15</sup> Within the operating temperature range, the module meets 3GPP specifications.
16 Within the extended temperature range, the module remains the ability to establish and maintain functions such as SMS and data transmission, without any unrecoverable malfunction. Radio spectrum and radio network are not influenced, while one or more specifications, such as Pout, may exceed the specified tolerances of 3GPP. When the temperature returns to the operating temperature range, the module meets 3GPP specifications again.
17 The module's power consumption in PSM is much lower than that in power-off mode due to the following two designs:

More internal power supplies are powers off in PSM.

The internal clock frequency is reduced in PSM.



	LTE Cat M1 e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s	19.57	mA
	B1 @ 20.66 dBm	200.47	mA
	B2 @ 20.81 dBm	202.12	mA
	B3 @ 21.24 dBm	199.57	mA
	B4 @ 20.82 dBm	197.79	mA
	B5 @ 21.12 dBm	219.9	mA
	B8 @ 21.03 dBm	209.96	mA
	B12 @ 20.67 dBm	202.55	mA
	B13 @ 20.92 dBm	225.42	mA
LTE Cat M1 data transfer	B18 @ 21.02 dBm	214.87	mA
(GNSS OFF)	B19 @ 20.95 dBm	216.17	mA
	B20 @ 20.96 dBm	214.52	mA
	B25 @ 21.02 dBm	203.86	mA
	B26 @ 21.06 dBm	218.97	mA
	B27 @ 20.8 dBm	212.89	mA
	B28A @ 20.89 dBm	210.15	mA
	B28B @ 21 dBm	217.13	mA
	B66 @ 21.03 dBm	198.63	mA
	B85 @ 21 dBm	203.36	mA

## 7.4.2. PCUL11-LD Power Consumption

Table 39: PCUL11-LD Power Consumption (3.8 V Power Supply, Room Temperature)

Description	Conditions	Average	Unit
Leakage	Power-off @ USB and UART disconnected	12.99	μΑ
PSM <sup>18</sup>	Power Saving Mode	3.89	μΑ

<sup>&</sup>lt;sup>18</sup> The module's power consumption in PSM is much lower than that in power-off mode due to the following two designs:

The module's USB and UART are disconnected and GSM network (if available) does not support PSM.

More internal power supplies are powers off in PSM.

<sup>•</sup> The internal clock frequency is reduced in PSM.



Rock Bottom	AT+CFUN=0 @ Sleep mode	0.575	mA
	LTE Cat M1 DRX = 1.28 s	1.89	mA
	LTE Cat NB DRX = 1.28 s	1.49	mA
	EGSM900 DRX = 5	1.21	mA
Sleep Mode (USB disconnected)	DCS1800 DRX = 5	1.20	mA
	LTE Cat M1 e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s LTE Cat NB	0.63	mA
	e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s	0.67	mA
	LTE Cat M1 DRX = 1.28 s	18.9	mA
L III - AA - I -	LTE Cat NB DRX = 1.28 s	14.8	mA
Idle Mode (USB disconnected)	LTE Cat M1 e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s	18.2	mA
	LTE Cat NB e-I-DRX = 81.92 s @ PTW = 2.56 s, DRX = 1.28 s	14.3	mA
	B1 @ 21.29 dBm	193.65	mA
	B2 @ 20.73 dBm	190.76	mA
	B3 @ 20.67 dBm	185.89	mA
	B4 @ 20.85 dBm	185.14	mA
	B5 @ 21.02 dBm	194.99	mA
	B8 @ 21.02 dBm	197.31	mA
	B12 @ 20.96 dBm	189.54	mA
LTE Cat M1 data transfer	B13 @ 20.99 dBm	198.75	mA
(GNSS OFF)	B18 @ 21 dBm	195.07	mA
	B19 @ 20.95 dBm	197.63	mA
	B20 @ 20.92 dBm	197.33	mA
	B25 @ 21.08 dBm	190.67	mA
	B26 @ 20.98 dBm	195.96	mA
	B27 @ 20.69 dBm	192.07	mA
	B28A @ 20.87 dBm	192.04	mA
	B28B @ 21.03 dBm	197.39	mA



	B66 @ 21.11 dBm	188.1	mA
	B85 @ 20.87 dBm	185.3	mA
	B1 @ 20.86 dBm	153.2	mA
	B2 @ 21.28 dBm	155.14	mA
	B3 @ 21.07 dBm	149.14	mA
	B4 @ 20.91 dBm	147.72	mA
	B5 @ 20.55 dBm	154.68	mA
	B8 @ 21.01 dBm	158.82	mA
	B12 @ 20.88 dBm	148.37	mA
LTE Cat NB data transfer	B13 @ 21.09 dBm	167.03	mA
(GNSS OFF)	B18 @ 20.79 dBm	157.12	mA
	B19 @ 20.68 dBm	156.29	mA
	B20 @ 21.01 dBm	161.75	mA
	B25 @ 21.02 dBm	154.16	mA
	B28 @ 20.82 dBm	147.82	mA
	B66 @ 21 dBm	148.58	mA
	B71 @ 20.81 dBm	137.53	mA
	B85 @ 20.64 dBm	146.51	mA
	GSM850 4UL/1DL @ 30.5 dBm	670.73	mA
	EGSM900 4UL/1DL @ 29.65 dBm	623.34	mA
GPRS data transfer	DCS1800 4UL/1DL @ 26.24 dBm	408.25	mA
(GNSS OFF)	PCS1900 4UL/1DL @ 26.43 dBm	423.12	mA
	EGSM900 1UL/4DL @ 31.96 dBm	255.82	mA
	DCS1800 1UL/4DL @ 29.35 dBm	179.29	mA
	GSM850 4UL/1DL @ 22.97 dBm	519	mA
EDGE data transfer	EGSM900 4UL/1DL @ 22.51 dBm	517.59	mA
(GNSS OFF)	DCS1800 4UL/1DL @ 22.73 dBm	439.73	mA
	PCS1900 4UL/1DL @ 22.27 dBm	443.94	mA



# 7.4.3. PCUL11 Series GNSS Power Consumption

Table 40: GNSS Power Consumption of PCUL11-LD1 (3.3 V Power Supply, Room Temperature)

Description	Conditions	Тур.	Unit
	Cold start @ Instrument	76.74	mA
Acquisition	Hot start @ Instrument	74.04	mA
(AT+CFUN=0)	Warm start @ Instrument	76.19	mA
	Lost state @ Instrument	76.05	mA
	Instrument Environment @ Passive Antenna	23.14	mA
Tracking (AT+CFUN=0)	Open Sky @ Real network, Passive Antenna	26.352	mA
,	Open Sky @ Real network, Active Antenna	27.463	mA

Table 41: GNSS Power Consumption of PCUL11-LD (3.8 V Power Supply, Room Temperature)

Description	Conditions	Тур.	Unit
	Cold start @ Instrument	70.00	mA
Acquisition	Hot start @ Instrument	73.66	mA
(AT+CFUN=0)	Warm start @ Instrument	72.54	mA
	Lost state @ Instrument	69.24	mA
	Instrument Environment @ Passive Antenna	22.31	mA
Tracking (AT+CFUN=0)	Open Sky @ Real network, Passive Antenna	21.792	mA
	Open Sky @ Real network, Active Antenna	22.357	mA

# 7.5. Tx Power

Table 42: Conducted Tx Power of PCUL11 Series

Frequency Bands	Max. Tx Power	Min. Tx Power	
-----------------	---------------	---------------	--



LTE HD-FDD B1/B2/B3/B4/B5/B8/B12/B13/B18/ B19/B20/B25/B26/B27/B28/B66/B71/B85	21 dBm +1.7/-3 dB	< -39 dBm
GSM850/EGSM900	33 dBm ±2 dB	5 dBm ±5 dB
DCS1800/PCS1900	30 dBm ±2 dB	0 dBm ±5 dB
GSM850/EGSM900 (8-PSK)	27 dBm ±3 dB	5 dBm ±5 dB
DCS1800/PCS1900 (8-PSK)	26 dBm ±3 dB	0 dBm ±5 dB

- 1. LTE HD-FDD B26 and B27 are supported by Cat M1 only.
- 2. LTE HD-FDD B71 is supported by Cat NB2 only.
- 3. For GPRS transmission on 4 uplink timeslots, the maximum output power reduction is 4.0 dB. The design conforms to *3GPP TS 51.010-1 subclause 13.16*.

# 7.6. Rx Sensitivity

Table 43: PCUL11-LD1 Conducted Rx Sensitivity

Mode	Band	Primary Diversity	Divorcity	Receiving Sensitivity (dBm)		
Wode	Dallu		Diversity	Cat M1/3GPP	Cat NB2	
	LTE HD-FDD B1			-108/-102.3		
	LTE HD-FDD B2			-108.4/-100.3		
	LTE HD-FDD B3			-108.4/-99.3		
	LTE HD-FDD B4	_	-	-108/-102.3		
	LTE HD-FDD B5	Supported		-107.6/-100.8		
LTE	LTE HD-FDD B8			-108/-99.8		
LIE	LTE HD-FDD B12			-108.6/-99.3	- <b>-</b>	
	LTE HD-FDD B13			-107/-99.3		
	LTE HD-FDD B18			-108/-102.3		
	LTE HD-FDD B19			-108/-102.3		
	LTE HD-FDD B20			-108/-99.8		
	LTE HD-FDD B25	_		-108.2/-100.3	_	



LTE HD-FDD	B26	-108.2/-100.3
LTE HD-FDD	B27	-108.4/-100.8
LTE HD-FDD	B28	-106.8/-100.8
LTE HD-FDD	B66	-107.8/-101.8
LTE HD-FDD	B85	-108.4/-99.3

Table 44: PCUL11-LD Conducted Rx Sensitivity

Mode	Band	Primary	Diversity	Receiver Sensitivity (dBm)		
Mode	Ballu	Primary Diversity		Cat M1/3GPP	Cat NB2 <sup>19</sup> /3GPP	
	LTE HD-FDD B1			-106.5/-102.3	-113/-107.5	
	LTE HD-FDD B2			-106/-100.3	-114/-107.5	
	LTE HD-FDD B3			-106/-99.3	-114/-107.5	
	LTE HD-FDD B4			-106.5/-102.3	-114/-107.5	
	LTE HD-FDD B5			-106/-100.8	-115/-107.5	
	LTE HD-FDD B8			-106/-99.8	-114/-107.5	
	LTE HD-FDD B12	Supported -		-106.5/-99.3	-115/-107.5	
	LTE HD-FDD B13			-106.5-99.3	-115/-107.5	
LTE	LTE HD-FDD B18		-	-106/-102.3	-115/-107.5	
LIL	LTE HD-FDD B19			-106/-102.3	-115/-107.5	
	LTE HD-FDD B20			-106/-99.8	-114/-107.5	
	LTE HD-FDD B25			-106/-100.3	-114/-107.5	
	LTE HD-FDD B26			-106/-100.3	-	
	LTE HD-FDD B27			-106.5/-100.8	-	
	LTE HD-FDD B28			-106/-100.8	-115/-107.5	
	LTE HD-FDD B66			-106.5/-101.8	-114/-107.5	
	LTE HD-FDD B71			-	-115/-107.5	
	LTE HD-FDD B85			-106.5/-99.3	-115/-107.5	

<sup>&</sup>lt;sup>19</sup> 3GPP has made no requirements for LTE Cat NB Rx Sensitivity repetition.



Mede Den	Dand	Deimone	Disconsitu	Receiver Sensitivity (dBm)
Mode	Band	Primary	Diversity -	GSM/3GPP
	GSM850			-107/-102
GPRS	EGSM900			-107/-102
(CS2)	DCS1800	Supported	-	-107/-102
	PCS1900			-106/-102

-: not supported.

#### 7.7. ESD Protection

Static electricity occurs naturally and it may damage the module. Therefore, it is imperative to adopt proper ESD countermeasures and handling methods. For example, wear anti-static gloves during the development, production, assembly and testing of the module; add ESD protection components to the ESD sensitive interfaces and points in the product design.

Table 45: Electrostatic Discharge Characteristics (Temperature: 25–30 °C, Humidity: 40 ±5 %)

Tested Interfaces	Contact Discharge	Air Discharge	Unit
VBAT, GND	±6	±8	kV
Main/GNSS Antenna Interfaces	±5	±6	kV



# 8 Mechanical Information

This chapter describes the mechanical dimensions of the module. All dimensions are measured in millimeter (mm), and the dimensional tolerances are ±0.2 mm unless otherwise specified.

# 8.1. Mechanical Dimensions

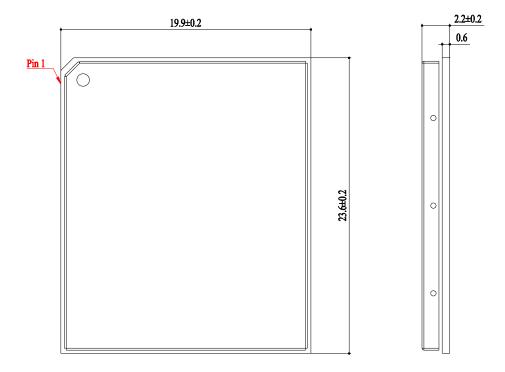


Figure 36: Module Top and Side Dimensions (Unit: mm)

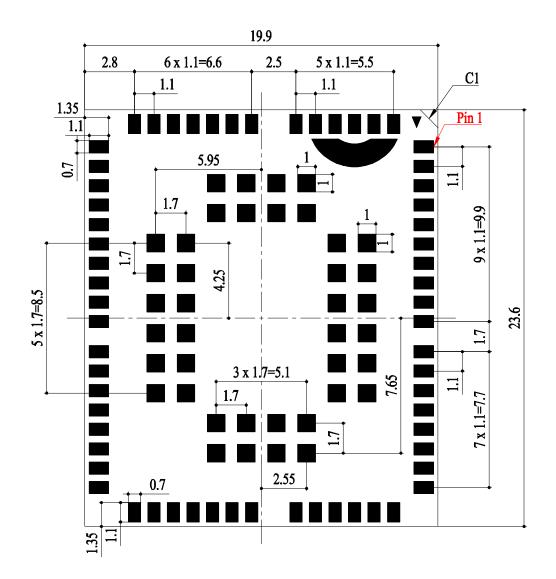


Figure 37: Module Bottom Dimensions

The package warpage level of the module refers to *JEITA ED-7306* standard.

8.2.

# 8.2. Recommended Footprint

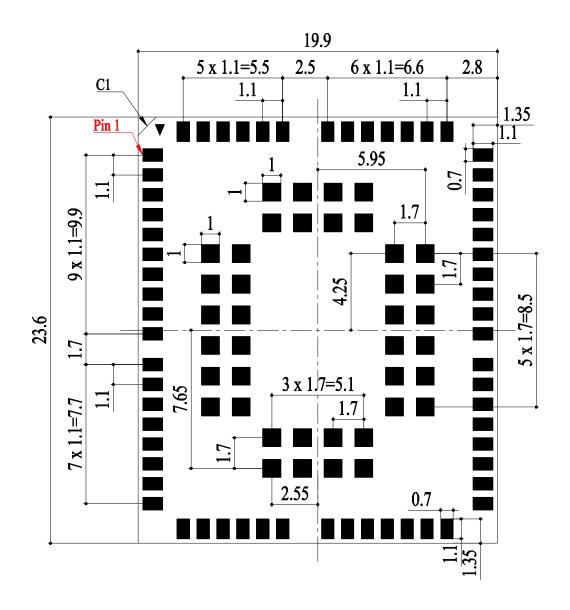


Figure 38: Recommended Footprint

Keep at least 3 mm between the module and other components on the motherboard to improve soldering quality and maintenance convenience.

8.3.

# 8.3. Top and Bottom Views

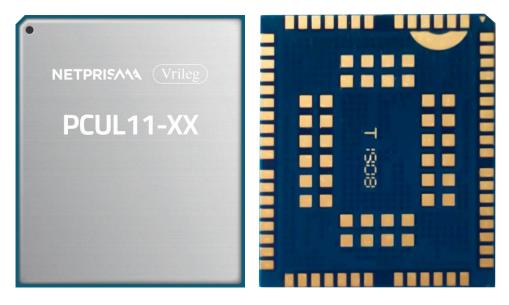


Figure 39: Top and Bottom Views of the Module

Images above are for illustration purpose only and may differ from the actual module. For authentic appearance and label, please refer to the module received from NetPrisma.

# Storage, Manufacturing and Packaging

# 9.1. Storage Conditions

The module is provided with vacuum-sealed packaging. MSL of the module is rated as 3. The storage requirements are shown below.

- 1. Recommended Storage Condition: the temperature should be 23 ±5 °C and the relative humidity should be 35–60 %.
- 2. Shelf life (in a vacuum-sealed packaging): 12 months in Recommended Storage Condition.
- 3. Floor life: 168 hours <sup>20</sup> in a factory where the temperature is 23 ±5 °C and relative humidity is below 60 %. After the vacuum-sealed packaging is removed, the module must be processed in reflow soldering or other high-temperature operations within 168 hours. Otherwise, the module should be stored in an environment where the relative humidity is less than 10 % (e.g., a dry cabinet).
- 4. The module should be pre-baked to avoid blistering, cracks and inner-layer separation in PCB under the following circumstances:
  - The module is not stored in Recommended Storage Condition;
  - Violation of the third requirement mentioned above;
  - Vacuum-sealed packaging is broken, or the packaging has been removed for over 24 hours;
  - Before module repairing.
- 5. If needed, the pre-baking should follow the requirements below:
  - The module should be baked for 8 hours at 120 ±5 °C;
  - The module must be soldered to PCB within 24 hours after the baking, otherwise it should be put in a dry environment such as in a dry cabinet.

#### NOTE

1. To avoid blistering, layer separation and other soldering issues, extended exposure of the module to the air is forbidden.

<sup>&</sup>lt;sup>20</sup> This floor life is only applicable when the environment conforms to *IPC/JEDEC J-STD-033*. It is recommended to start the solder reflow process within 24 hours after the package is removed if the temperature and moisture do not conform to, or are not sure to conform to *IPC/JEDEC J-STD-033*. Do not unpack the modules in large quantities until they are ready for soldering.



- 2. Take out the module from the package and put it on high-temperature-resistant fixtures before baking. If shorter baking time is desired, see *IPC/JEDEC J-STD-033* for the baking procedure.
- 3. Pay attention to ESD protection, such as wearing anti-static gloves, when touching the modules.

# 9.2. Manufacturing and Soldering

Push the squeegee to apply the solder paste on the surface of stencil, thus making the paste fill the stencil openings and then penetrate to the PCB. Apply proper force on the squeegee to produce a clean stencil surface on a single pass. To guarantee module soldering quality, the thickness of stencil for the module is recommended to be 0.13–0.15 mm. For more details, see **document [6]**.

The recommended peak reflow temperature should be 235–246 °C, with 246 °C as the absolute maximum reflow temperature. To avoid damage to the module caused by repeated heating, it is recommended that the module should be mounted only after reflow soldering for the other side of PCB has been completed. The recommended reflow soldering thermal profile (lead-free reflow soldering) and related parameters are shown below.

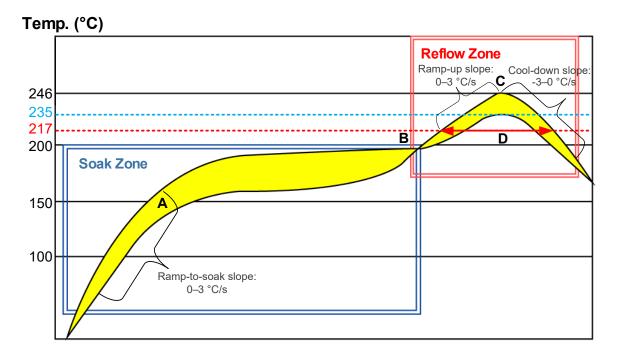


Figure 40: Recommended Reflow Soldering Thermal Profile

Table 46: Recommended Thermal Profile Parameters

Factor	Recommended Value
Soak Zone	
Ramp-to-soak Slope	0–3 °C/s
Soak Time (between A and B: 150 °C and 200 °C)	70–120 s
Reflow Zone	
Ramp-up Slope	0–3 °C/s



Reflow Time (D: over 217°C)	40–70 s
Max Temperature	235–246 °C
Cool-down Slope	-3–0 °C/s
Reflow Cycle	
Max Reflow Cycle	1

- 1. The above profile parameter requirements are for the measured temperature of the solder joints. Both the hottest and coldest spots of solder joints on the PCB should meet the above requirements.
- 2. If a conformal coating is necessary for the module, do NOT use any coating material that may chemically react with the PCB or shielding cover, and prevent the coating material from flowing into the module.
- 3. Avoid using ultrasonic technology for module cleaning since it can damage crystals inside the module.
- 4. Avoid using materials that contain mercury (Hg), such as adhesives, for module processing, even if the materials are RoHS compliant and their mercury content is below 1000 ppm (0.1 %).

Due to the complexity of the SMT process, please contact NetPrisma Technical Supports in advance for any situation that you are not sure about, or any process (e.g., selective soldering, ultrasonic soldering) that is not mentioned in *document* [7].

#### 9.3.

# 9.3. Packaging Specifications

This chapter outlines the key packaging parameters and processes. All figures below are for reference purposes only, as the actual appearance and structure of packaging materials may vary in delivery.

The modules are packed in a tape and reel packaging as specified in the sub-chapters below.

## 9.3.1. Carrier Tape

Carrier tape dimensions are illustrated in the following figure and table:

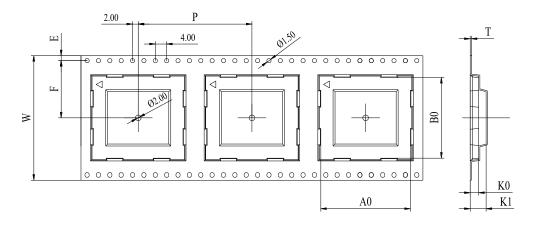


Figure 41: Carrier Tape Dimension Drawing (Unit: mm)

Table 47: Carrier Tape Dimension Table (Unit: mm)

W	Р	Т	A0	В0	K0	<b>K</b> 1	F	Е
44	32	0.35	20.2	24	3.15	6.65	20.2	1.75

#### 9.3.2. Plastic Reel

Plastic reel dimensions are illustrated in the following figure and table:

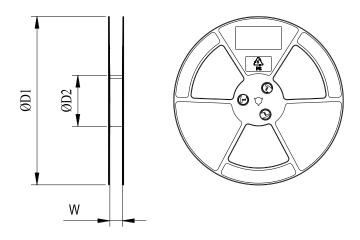


Figure 42: Plastic Reel Dimension Drawing

Table 48: Plastic Reel Dimension Table (Unit: mm)

øD1	øD2	W
330	100	44.5



#### 9.3.3. Mounting Direction

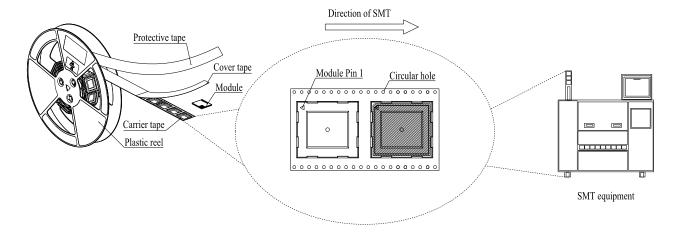
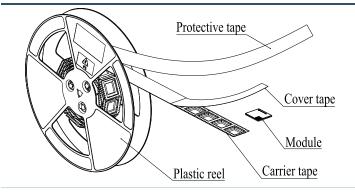


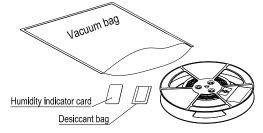
Figure 43: Mounting Direction

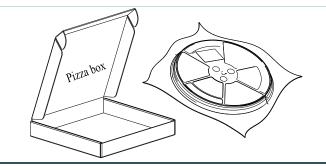
#### 9.3.4. Packaging Process



Place the modules onto the carrier tape cavity and cover them securely with cover tape. Wind the heat-sealed carrier tape onto a plastic reel and apply a protective tape for additional protection. 1 plastic reel can pack 250 modules.

Place the packaged plastic reel, humidity indicator card and desiccant bag into a vacuum bag, and vacuumize it.





Place the vacuum-packed plastic reel into a pizza box.



Place the 4 packaged pizza boxes into 1 carton and seal it. 1 carton can pack 1000 modules.

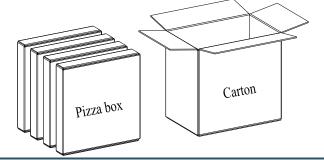


Figure 44: Packaging Process

Table 49: Packaging Specifications of PCUL11 Series Module

MOQ for MP	Minimum Package: 250	Minimum Package × 4 = 1000
250	Size: 370 mm × 350 mm × 56 mm Net Weight: 0.61 kg Gross Weight: 1.35 kg	Size: 380 mm × 250 mm × 365 mm Net Weight: 2.45 kg Gross Weight: 6.28 kg



# 10 Appendix A References

#### Table 50: Related Documents

Document Name
[1] NetPrisma_PCUL11_Series_GNSS_Application_Note
[2] NetPrisma_UMTS&LTE_EVB_User_Guide
[3] NetPrisma_PCUL11_Series_AT_Commands_Manual
[4] NetPrisma_PCUL11_Series_QCFG_AT_Commands_Manual
[5] NetPrisma_RF_Layout_Application_Note
[6] NetPrisma_Module_Stencil_Design_Requirements
[7] NetPrisma_Module_SMT_Application_Note

#### Table 51: Terms and Abbreviations

Abbreviation	Description
ASM	Antenna Switch Modules
bps	Bits per second
CHAP	Challenge Handshake Authentication Protocol
CS	Coding Scheme
CTS	Clear To Send
DFOTA	Delta Firmware Upgrade Over-The-Air
DL	Downlink
DTR	Data Terminal Ready
e-I-DRX	Extended Idle Mode Discontinuous Reception
EPC	Evolved Packet Core



ESD	Electrostatic Discharge
FDD	Frequency Division Duplex
GMSK	Gaussian Minimum Shift Keying
GSM	Global System for Mobile Communications
HSS	Home Subscriber Server
I2C	Inter-Integrated Circuit
I/O	Input/Output
LED	Light Emitting Diode
LDO	Low-dropout Regulator
LNA	Low Noise Amplifier
LPF	Low-Pass Filter
LTE	Long Term Evolution
MO	Mobile Originated
MOQ	Minimum Order Quantity
MT	Mobile Terminated
PA	Power Amplifier
PAP	Password Authentication Protocol
РСВ	Printed Circuit Board
PDU	Protocol Data Unit
PMIC	Power Management IC
PPP	Point-to-Point Protocol
PSM	Power Saving Mode
RF	Radio Frequency
RHCP	Right Hand Circularly Polarized
Rx	Receive
SAW	Surface Acoustic Wave
SMS	Short Message Service
TDD	Time Division Duplex



TX	Transmit
UL	Uplink
UE	User Equipment
URC	Unsolicited Result Code
(U)SIM	(Universal) Subscriber Identity Module
Vmax	Maximum Voltage
Vnom	Nominal Voltage
Vmin	Minimum Voltage
V <sub>IH</sub> max	Maximum High-Level Input Voltage
V <sub>IH</sub> min	Minimum High-level Input Voltage
V <sub>IL</sub> max	Maximum Low-level Input Voltage
V <sub>IL</sub> min	Minimum Low-level Input Voltage
V <sub>I</sub> max	Absolute Maximum Input Voltage
V <sub>I</sub> min	Absolute Minimum Input Voltage
V <sub>OH</sub> max	Maximum High-level Output Voltage
V <sub>OH</sub> min	Minimum High-level Output Voltage
V <sub>OL</sub> max	Maximum Low-level Output Voltage
V <sub>OL</sub> min	Minimum Low-level Output Voltage
VSWR	Voltage Standing Wave Ratio
WWAN	Wireless Wide Area Network